HP 11661A

FREQUENCY EXTENSION MODULE 11661A

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(1661A FREQUENCY EXTENSION MODULE





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Thanks

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OPERATING AND SERVICE MANUAL

FREQUENCY EXTENSION MODULE 11661A

SERIAL NUMBERS

This manual applies directly to instruments with serial numbers prefixed 1433A.

With changes described in Section VII, this manual also applies to instruments with serial numbers prefixed 1216A, 1244A, 1248A, 1250A, 1339A, 1409A, 1412A, and 1430A.

For additional important information about serial numbers, see INSTRUMENTS COVERED BY MANUAL in Section I.

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WARNINGS

SAFETY

Although this instrument has been designed in accordance with international safety standards, this manual contains information, cautions, and warnings which must be followed to retain the instrument in safe condition. Be sure to read and follow the safety information in Sections II, V, and VIII.

BEFORE CONNECTING THIS SYSTEM TO LINE (MAINS) VOLTAGE, the safety and installation instructions found in Sections II and III of the mainframe manual should be followed.

HIGH VOLTAGE

To avoid contact with the line voltage, remove the line (main) power cable from the power outlet before removing or connecting the Frequency Extension Module.

Capacitors inside the instrument may still be charged even if the system has been disconnected from its source of supply.

Adjustments and troubleshooting are often performed with power supplied to the instrument while protective covers are removed. Energy available at many points may, if contacted, result in personal injury.

The multi-pin plug connector (on mainframe), which provides interconnection to the Extension Module will expose power supply voltages which may remain on the pins after the Extension Module is removed and after the (Mains) power cable is disconnected from the mainframe. Be careful to avoid contact with the pins during interconnection with the Extension Module.

CAUTIONS

PERFORMANCE TESTING

To avoid the possibility of damage to the instrument or test equipment, read completely through each test before starting it. Then make any preliminary control settings necessary before continuing with the procedure.

PLUG-IN REMOVAL

Before removing the Frequency Extension Module plug-in from the mainframe, remove the line (Mains) voltage by disconnecting the power cable from the power outlet.



Figure 1-1. Model 11661A and Accessories Supplied

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SECTION I GENERAL INFORMATION

1-1. INTRODUCTION

1-2. This manual contains all information required to install, operate, test, adjust and service the Hewlett-Packard 11661A Frequency Extension Module plug-in, hereinafter referred to as the Extension Module. For more information on related instruments such as the Model 8660-series mainframes, 86600-series RF Section plug-ins, or 86630-series Modulation Section plug-ins, refer to the appropriate manual.

1-3. This manual is divided into eight sections which provide information as follows:

a. SECTION I, GENERAL INFORMA-TION, contains the instrument description as well as the accessory and recommended test equipment test.

b. SECTION II, INSTALLATION, contains information relative to receiving inspection, preparation for use, mounting, packing, and shipping.

c. SECTION III, OPERATION, provides information relative to instrument operation.

d. SECTION IV, PERFORMANCE TESTS, provides information required to ascertain that the instrument is performing in accordance with published specifications.

e. SECTION V, ADJUSTMENTS, contains information required to properly adjust and align the instrument after repair.

f. SECTION VI, REPLACEABLE PARTS, contains information required to order all parts and assemblies or effect exchange of assemblies.

g. SECTION VII, MANUAL CHANGES, normally contains backdating information to make this manual compatible with earlier equipment configurations.

h. SECTION VIII, SERVICE, contains descriptions of the circuits, schematic diagrams, parts location diagrams, and troubleshooting procedures to aid the user in maintaining the instrument. 1-4. Figure 1-1 shows the Extension Module with included accessories.

1-5. On the title page of this manual, below the manual part number, is a "Microfiche" part number. This number may be used to order 4x6-inch microfilm transparencies of the manual. Each microfiche contains up to 60 photo-duplicates of the manual pages. The microfiche package also includes the latest Manual Changes supplement as well as all pertinent Service Notes.

1-6. SPECIFICATIONS

1-7. Specifications for the Extension Module and RF Section plug-ins are combined. Refer to the RF Section manual for the combined specifications.

1-8. INSTRUMENTS COVERED BY MANUAL

1-9. This instrument has a two-part serial number. The first four digits and the letter comprise the serial number prefix. The last five digits form the sequential suffix that is unique to each instrument. The contents of this manual apply directly to instruments having the same serial number prefix(es) as listed under SERIAL NUMBERS on the title page.

1-10. An instrument manufactured after the printing of this manual may have a serial prefix that is not listed on the title page. This unlisted serial prefix indicates that the instrument is different from those documented in this manual. The manual for this instrument is supplied with a yellow Manual Changes supplement that contains "change information" that documents the differences.

1-11. In addition to change information, the supplement may contain information for correcting errors in the manual. To keep this manual as current and accurate as possible, Hewlett-Packard recommends that you periodically request the latest Manual Changes supplement. The supplement for this manual is keyed to this manual's print date and part number, both of which appear on the title page. Complimentary copies of the supplement are available from Hewlett-Packard. 1-12. For information concerning a serial number prefix not listed on the title page or in the Manual Changes supplement, contact your nearest Hewlett-Packard office.

1-13. DESCRIPTION

1-14. The HP Model 11661A Frequency Extension Module plug-in extends the output frequency range of the mainframe to meet the input requirements **RF** Section plug-ins of high-frequency (>160 MHz). The Extension Module contains two high-frequency phase-locked loops which receive digital tuning signals, variable synthesized signals, and fixed synthesized signals from the main-The phase-locked loops use the mainframe. frame signals in conjunction with a 4.43 GHz oscillator output that is common to both loops to produce two high-frequency output signals. One output signal is generated by a phase-locked summing loop using a Voltage Controlled Oscillator (VCO) that is tuneable in 1 Hz steps (100 Hz steps for option 004 mainframe) over the 3.95 to 4.05 GHz range. The other output signal is generated by a phase-locked loop using a Yittrium-Iron -Garnet (YIG) oscillator that is tunable in 100 MHz steps over the 2.75 to 3.95 GHz range. Since both phase-locked loops use the same 4.43 GHz oscillator, variations in the oscillator frequency do not affect the frequency difference between the summing loop and YIG loop outputs. The two output signals from the Extension Module are coupled to the RF Section plug-ins for mixing, amplification of the converted signal, and final output power level control.

1-15. Frequency modulation (FM) of the YIG loop output can be effected by supplying a frequency modulated reference signal instead of a fixed reference signal, to a phase detector in the phase-locked YIG loop. Thus, as the frequency modulated reference signal varies, the YIG loop output frequency varies accordingly.

1-16. ACCESSORIES SUPPLIED

1-17. Two coaxial cables, HP Part Numbers 11661-60026 (Gray-blue) and 11661-60028 (Gray), are supplied with the Extension Module. The cables are used to interconnect the YIG and SUM loop outputs to the RF Section inputs. The accessories are shown with the Extension Module in Figure 1-1.

1-18. EQUIPMENT REQUIRED BUT NOT SUPPLIED

1-19. Each Frequency Extension Module is installed in a plug-in cavity within an 8660-series mainframe. Logic control inputs, RF inputs, and power supply inputs are connected directly from the mainframe or through a compatible 86600-series RF Section plug-in to the Extension Module. The Extension Module outputs are connected to the RF Section.

1-20. The Synthesized Signal Generator System requires installation of an Auxiliary or Modulation Section. The only direct interaction between a Modulation Section and the Extension Module occurs when a frequency modulated RF output is selected. A 86630-series plug-in with FM capability couples a frequency modulated RF signal to the Extension Module. The FM portion of this signal is superimposed on an RF output to the RF Section.

1-21. EQUIPMENT AVAILABLE

1-22. An extender cable, HP Part Number 11672-60002, is required to extend the Extension Module for maintenance purposes. The extender cable is part of the HP 11672A Service Kit but may be ordered separately.

1-23. Extender cards used in servicing the Extension Module are contained in the HP Rack Mount Kit, HP Part Number 08660-60070, which is supplied with the mainframe.

1-24. RECOMMENDED TEST EQUIPMENT

1-25. Table 1-1 lists the test equipment and accessories recommended for use in testing, adjusting, and servicing the Extension Module. If any of the recommended test equipment is unavailable, instruments with equivalent specifications may be used.

1-26. SAFETY CONSIDERATIONS

1-27. This instrument has been designed in accordance with international safety standards and has been supplied in safe condition.

1-28. Although this instrument has been designed in accordance with international safety standards, this manual contains information, cautions, and warnings which must be followed to retain the instrument in safe condition. Be sure to read and follow the safety information in Sections II, V, and VIII.

Item	Item Critical Specifications			
Digital Voltmeter	Accuracy: ±0.2% Range: 0.00 to 60 Volts	HP 34740 with HP 34702A	A,T	
Oscilloscope	Vertical: Bandwidth 50 MHz with sensitivity of 5 mV/division minimum Horizontal: Sweep time 10 ns to 1s Delayed sweep External triggering to 100 MHz	HP 180A with HP 1801A and HP 1821A plug-ins	A.T	
10:1 divider probe	10:1 divider 10 Megohm 10 pF	HP 10004	A,T	
Spectrum Analyzer	Absolute Accuracy ±1.6 dB from 10 MHz to 1.3 GHz Measurement Accuracy ±2.6 dB from 10 MHz to 1.3 GHz	HP 8555A with HP 8552B and HP 140T	A,T	
Test Oscillator	1 kHz to 20 kHz 0.2 to 2.0 Vrms into 50Ω	HP 651B	Α	
Microwave Frequency Counter	Range: 0.2 - 1300 MHz Resolution: 1 Hz	HP 5340A	A,T	
Frequency Synthesizer	20 to 30 MHz settable in 1 Hz increments Phase Modulation ±3 radians deviation	HP 5105A/5110B	A	
VHF Oscillator	10 to 30 MHz Leveled Output	HP 8654A	А	
Extender Board	24 Contact (2 x 12 pins) Supplied with mainframe rack mounting kit.	HP 5060-0258	A,T	
Step Attenuator (10 dB)	0 to 120 dB in 10 dB steps Range: 10 to 550 MHz Accuracy: ±1.5 dB to 90 dB	HP 355D	A	
Service Kit	Interconnect cables, adaptors coaxial cables compatible to 8660-series plugs and jacks	HP 11672A (see Operating Note or mainframe manual for parts list)	A,T	

Table 1-1.	Recommended	Test	Equipment

*A = Adjustments; T = Troubleshooting

SECTION II

2-1. INTRODUCTION

2-2. This section contains information related to the initial inspection, preparation for use, and storage and shipping instructions for the Frequency Extension Module.

2-3. INITIAL INSPECTION

NOTE

If the Extension Module has been received as part of a signal generator system (8660-series Option 100), for mechanical inspection purposes the module should be considered part of the mainframe. Refer to the RF Section manual for information related to electrical inspection.

2-4. Inspect the shipping container for damage. If the shipping container or cushioning material is damaged, it should be kept until the contents of the shipment have been checked for completeness and the instrument has been checked mechanically and electrically. The contents of the shipment should be as shown in Figure 1-1, and procedures for checking electrical performance are given in the RF Section manual. If the contents are incomplete, if there is mechanical damage or defect, or if the instrument does not pass the electrical performance test, notify the nearest Hewlett-Packard office. If the shipping container is damaged, or the cushioning material shows signs of stress, notify the carrier as well as the Hewlett-Packard office. Keep the shipping materials for carrier's inspection. The HP office will arrange for repair or replacement without waiting for claim settlement.

2-5. PREPARATION FOR USE

2-6. Power Requirements

2-7. The power consumed by the Frequency Extension Module during normal operation is 50 VA maximum.

2-8. Interconnections

2-9. Installing the Extension Module into the mainframe plug-in cavity ensures all necessary connections are made to the mainframe and the Modulation Section plug-in. Two coaxial cable accessories also must be installed to complete necessary connections to the RF Section plug-in.

2-10. Operating Environment

2-11. The Extension Module is designed to operate a mainframe which is operating within the following environment conditions:

Temperature	е					$\cdot \cdot \cdot \cdot \cdot \cdot 0$ to $55^{\circ}C$
						(+32 to +131°F)
Humidity			•			. less than 95% relative
Altitude	•	•	•	•	•	. less than 15,000 feet

2-12. Installation Instructions

2-13. Safety Considerations. During installation of the Extension Module, the top and bottom protective covers of the mainframe are removed. Energy available at many points may, if contacted, result in personal injury.

WARNINGS

1. Disconnect line (Mains) power cable from mainframe to remove available energy.

2. Capacitors inside the instrument may still be charged even if the system has been disconnected from its source of supply.

3. The multi-pin connector (mounted on mainframe) which provides interconnection to the Extension Module exposes power supply voltages which may remain after the power cable is disconnected from mainframe.

2-14. Order of Installation Procedures. If the Extension Module is being installed in the main-frame for the first time, perform the following

procedures in the order listed. To reinstall the Extension Module, perform only the Extension Module Installation.

a. Accessory Cable Installation, Figure 2-1.

b. Extension Module Installation, Figure 2-2.

c. Abbreviated Adjustment procedure in Section V.

2-15. STORAGE AND SHIPMENT

2-16. Environment

2-17. The storage and shipping environment of the Extension Module should not exceed the following limits:

Temperature)			•	•	-40° to $+75^{\circ}$ C
						$(-40^{\circ} \text{ to } +167^{\circ} \text{ F})$
Humidity		•	•	•	•	less than 95%, relative
Altitude	•	•	•	•	•	. less than 25,000 feet

2-18. Packaging

2-19. Original Type Packaging. Containers and materials identical to those used in factory packaging are available through Hewlett-Packard offices. If the instrument is being returned to HewlettPackard for servicing, attach a tag indicating the type of service required, return address, model number, and full serial number. Also, mark the container FRAGILE to assure careful handling. In any correspondence, refer to the instrument by model number and full serial number.

2-20. Other Packaging. The following general instructions should be used for re-packaging with commercially available materials:

a. Wrap the instrument in heavy paper or plastic. (If shipping to a Hewlett-Packard office or service center, attach a tag indicating the type of service required, return address, model number, and full serial number.)

b. Use a strong shipping container. A double-wall carton made of 350-pound test material is adequate.

c. Use enough shock-absorbing material (3to 4-inch layer) around all sides of the instrument to provide firm cusion and prevent movement inside the container.

d. Seal the shipping container securely.

e. Mark the shipping container FRAGILE to assure careful handling.





c. Make sure the multi-pin connector mates properly with the mainframe connector and press the Extension Module into place.

d. Secure the Module in place with 5 Pozi-driv screws, 3 from the top as shown in the figure and 2 from the bottom of the mainframe.

e. Press the free end of the grey accessory cable into J1 and the grey-blue cable into J2 as shown in the figure.

SECTION III OPERATION

3-1. INTRODUCTION

3-2. The operation of the Frequency Extension Module is dependent on the Model 8660-series mainframe (frequency control) and the Model 86630-series Modulation Section plug-in. Refer to Section III of the appropriate manual for operating information.

SECTION IV PERFORMANCE TESTS

4-1. INTRODUCTION

4-2. The performance of RF Sections which have a high frequency limit greater than 160 MHz is dependent on the performance of the Frequency Extension Module. Refer to Section IV of the appropriate RF Section Operating and Service Manual for combined performance tests.

SECTION V ADJUSTMENTS

5-1. INTRODUCTION

5-2. This section contains adjustment procedures which will return the Frequency Extension Module to peak operating condition. An abbreviated procedure is included to adjust an Extension Module the first time it is used with a mainframe so they will operate with each other in the system.

5-3. The Extension Module should be adjusted after any repair or if the unit, in conjunction with the RF Section, fails to meet the performance tests of Section IV in the RF Section manual. Prior to making any adjustment, let the complete system warm up for 30 minutes.

5-4. The order in which the adjustments are made is critical. Perform the adjustments in sequence and under the conditions presented in this section. DO NOT attempt to make random adjustments to the instrument. The Abbreviated Adjustments are independent and are to be performed only under special conditions. Prior to making any adjustments to the Frequency Extension Module, refer to the paragraph entitled Related Adjustments.

5-5. EQUIPMENT REQUIRED

5-6. Each adjustment procedure in this section contains a list of test equipment and accessories required to perform the adjustment. The test equipment is also identified by callouts in the test setup diagrams included with each procedure.

5-7. If substitutions must be made for the specified test equipment, refer to Table 1-1 for the minimum specifications of the test equipment to be used in the adjustment procedures. Since the Synthesized Signal Generator System is extremely accurate, it is particularly important that the test equipment used in the adjustment procedures meets the critical specifications listed in Table 1-1.

5-8. The HP 11672A Service Kit is an accessory item available from Hewlett-Packard for use in maintaining the Frequency Extension Module. A detailed listing of the items contained in the service kit is provided in the HP 11672A Operating Note and the mainframe manual. Each item may be ordered separately. 5-9. Extender cards used in servicing the Extension Module are contained in the HP Rack Mount Kit, HP Part Number 08660-60070, which is supplied with the mainframe.

5-10. SAFETY CONSIDERATIONS

5-11. Although this instrument has been designed in accordance with international safety standards, this manual and the system mainframe manual contain information, cautions, and warnings which must be followed to ensure safe operation and to retain the complete system in safe condition. Service adjustments should be performed only by qualified service personnel.

NOTE

Refer to the mainframe manual for safety information relating to ac line (Mains) voltage, fuses, protective earth grounding, etc.

5-12. Any adjustment, maintenance, and repair of the opened instrument under voltage should be avoided as much as possible and, when inevitable, should be carried out only by a skilled person who is aware of the hazard involved.

5-13. Capacitors inside the instrument may still be charged even if the instrument has been disconnected from its source of supply.

WARNINGS

1. Adjustments described herein are performed with power supplied to the instrument while protective covers are removed. Energy available at many points may, if contacted, result in personal injury.

2. The multi-pin plug connector (on mainframe), which provides interconnection to the Extension Module will expose power supply voltages which may remain on the pins after the Extension Module is removed and after the (Mains) power cable is disconnected from the mainframe. Be careful to avoid contact with the pins during interconnection with the Extension Module.

5-14. FACTORY-SELECTED COMPONENTS

5-15. Factory-selected components are identified on the schematics and parts list by an asterisk which follows the reference designator. The nominal value of the components are normally shown. The manual change sheets will provide updated information pertaining to the selected components. Table 5-1 lists the reference designator, the criterion used for selecting a particular value, the normal value range, and the service sheet where the component part is shown.

5-16. RELATED ADJUSTMENTS

5-17. The adjustment procedures found in this section are normally performed in sequence. The Abbreviated Adjustment procedure is independent and is performed only when an Extension Module is being used with a mainframe for the first time.

5-18. If the 4.43 GHz Oscillator is adjusted, the procedures which follow must all be performed.

5-19. If the 20 MHz IF Amplifier Adjustment is performed, the YIG Pretune Driver Adjustment, the YIG Loop Phase Detector Adjustment, and the YIG Loop Gain and Bandwidth Adjustment must be performed in sequence.

5-20. If the 3.95 to 4.05 GHz VCO Bias Adjustment is performed, the Sum Loop Pretune Adjust-

ment and the Sum Loop Bandwidth Adjustment must be performed in sequence.

5-21. Only the Abbreviated Adjustment, the YIG Loop Gain Bandwidth Adjustment, and the Sum Loop Bandwidth Adjustment are independent of other procedures. The final checks of the Abbreviated Adjustment procedure indicate if the other procedures need to be performed.

5-22. ADJUSTMENT LOCATIONS

5-23. The last foldout in this manual contains a table which cross-references all pictorial and schematic locations of the adjustable controls. The figure accompanying the table shows the locations of assemblies, chassis mounted parts, adjustable components, and test points.

5-24. ADJUSTMENTS

5-25. Prior to performing the adjustments on the Extension Module, remove the mainframe and Extension Module top covers. Refer to the disassembly procedures found on the lefthand foldout page which preceeds the last foldout in this manual.

5-26. Prior to performing the COMPLETE adjustment procedures remove the five circuit board assemblies (A3 through A7).

Reference Designator	Selected for	Normal Value Range	Service Sheet
A4C8*	Sum Loop Bandwidth (3 dB down) of 500 ±150 kHz with center frequency set to 1.095 GHz. Increasing capacitance increases bandwidth.	200 to 330 pF	7
A3L2	Phase lock with an increase in center frequency (10 MHz steps). Monitor A3TP1 with an oscillo- scope. A dc level is observed if Sum Loop is phase locked as opposed to an ac signel when unlocked. The dc level should be observed in each of the following cases: Set system center frequency to 99.9 MHz; then to 109.9 MHz. Set to 299.9 MHz; then 309.9 MHz. Set to 399.9 MHz; then 409.9 MHz. Set to 799.9 MHz; then 809.9 MHz.	5.6 to 12.0 μH	6

Table 5-1. Factory Selected Components

5-27. ABBREVIATED ADJUSTMENT OF FREQUENCY EXTENSION MODULE

REFERENCE:

Service Sheets 5 and 7.

DESCRIPTION:

Each time a Frequency Extension Module is inserted into a different mainframe, minor adjustments must be made to the Extension Module to ensure proper operation of the entire signal generator system. Mainframe power supplies are checked and adjustments are made if necessary. An adjustment of the 4.43 GHz oscillator is done. The Sum Loop Pretune Assembly Outputs are adjusted and rechecked along with the 4.43 GHz oscillator. The dc voltage levels at A6TP1 of the YIG Loop Pretune Assembly are measured at specific preset frequencies.



Figure 5-1. Abbreviated Adjustment Test Setup

EQUIPMENT:

Microwave Frequency Counter...<th.</th>..</th

PROCEDURE:

1. Check the regulated power supply voltages in the mainframe (refer to Section VIII of the mainframe manual for the figure entitled Assembly Locations).

NOTE

DO NOT adjust the volte	ges if they are	within tolerance.
-------------------------	-----------------	-------------------

Mainframe Test Point	Voltage and Tolerance (Vdc)
A5TP1 A5TP2 A5TP3 A5TP4	$\begin{array}{r} -40.00 \pm 0.02 \\ -10.00 \pm 0.01 \\ +20.000 \pm 0.005 \\ + 5.25 \pm 0.02 \end{array}$

ADJUSTMENTS

5-27. ABBREVIATED ADJUSTMENT OF FREQUENCY EXTENSION MODULE (Cont'd)

- 2. Connect the RF SIGNAL OUTPUT from J2 of the Extension Module to the high frequency input of the microwave frequency counter.
- 3. Set the mainframe center frequency to 1200 MHz.
- 4. Set the R1 Control for an output from J2 (monitored by the microwave frequency counter) of 2750.000 ±0.100 MHz. (This indirectly sets the frequency of the 4.43 GHz Oscillator.)
- 5. Set the mainframe LINE switch control to STNDBY and place the A4 Assembly on an extender board.
- 6. Return the LINE switch to ON and Monitor the dc voltage on A3TP1 with a digital voltmeter.
- 7. As shown by the table, set the center frequency and adjust the appropriate control for a reading of 10 ± 1 Vdc on the digital voltmeter.

	Adjustable Control										
Center Frequency	Name	Reference Designator									
5 MHz	B Adj	A4R6									
15 MHz	1 Adj	A4R10									
25 MHz	2 Adj	A4R16									
35 MHz	3 Adj	A4R20									
45 MHz	4 Adj	A4R23									
55 MHz	5 Adj	A4R26									
65 MHz	6 Adj	A4R29									
75 MHz	7 Adj	A4R32									
85 MHz	8 Adj	A4R35									
95 MHz	9 Adj	A4R38									

- 8. Recheck the voltage readings at each center frequency setting (step 7).
- 9. Recheck the 4.43 GHz Oscillator frequency (see steps 3 and 4). If necessary, repeat steps 3 through 9.
- 10. Monitor the dc voltage on A6TP1 with the digital voltmeter while programming in 100 MHz steps from 0 (zero) to 1200 MHz (i.e., 0 MHz, 100 MHz, 100 MHz, ... 1200 MHz). The dc voltage should be 0.0 ± 0.5 Vdc for each center frequency setting.

NOTE

If the voltage at any frequency setting is $\ge \pm 0.5$ Vdc, perform the rest of the adjustment procedures in this section.

5-28. 4.43 GHz OSCILLATOR ADJUSTMENT

REFERENCE:

Service Sheet 3

DESCRIPTION:

The 443 GHz Oscillator output is monitored by a frequency counter while the frequency is adjusted.



Figure 5-2. 4.43 GHz Oscillator Adjustment Test Setup

EQUIPMENT:

Microwave Frequency Counter						. HP 5240A
Extender Cable		•			HI	P 11672-60002

PROCEDURE:

- 1. Interconnect equipment as illustrated in Figure 5-2.
- 2. Connect microwave frequency counter input to the 4.43 GHz OUT connector A1J3.
- 3. Adjust potentiometer R1 for 4.4300 ± 0.0005 GHz as indicated by the microwave frequency counter.

5-29. 20 MHz IF AMPLIFIER ADJUSTMENT

REFERENCE:

Service Sheet 3

DESCRIPTION:

A 20 MHz signal from the mainframe is attenuated and injected at the input of the 20 MHz IF amplifier. The output is monitored with an oscilloscope and the 20 MHz ADJ control is set for the peak signal output.

5-29. 20 MHz IF AMPLIFIER ADJUSTMENT (Cont'd)



Figure 5-3. 20 MHz IF Amplifier Adjustment Test Setup

EQUIPMENT:

Oscilloscope .			•						•		HP	180)A/	180	1A/1821A	١
10:1 Divider Probe			•							•		•		•	HP 10004	1
Step Attenuator (1	0 c	iΒ)				•		•			•				HP 3551)
Extender Cable .				•			•				•	•	HP	11	672-60002	2
5110 Ohm 1/4 Wat	t F	Res	isto	r	•	•	•	•	•	•	•	•	. 1	HP	0757-0438	3

PROCEDURE:

- 1. Remove the A1A1, A1A3, and A1A4 Assemblies' cover. Refer to the disassembly procedures on the lefthand foldout page which preceeds the last foldout.
- 2. Disconnect W4 from A1J4; W3 from A1J2.
- 3. Set the step attenuator controls for 20 dB attenuation.
- 4. Connect the equipment together as shown in Figure 5-3.
- 5. Set the oscilloscope controls to monitor the 20 MHz signal (amplitude normally about 1 Vp-p).
- 6. Peak the 20 MHz output as seen on the oscilloscope display by adjusting the A1A1C1 control.
- 7. Disconnect the equipment, connect W4 to A1J4, connect W3 to A1J2, and replace the A1A1, A1A3, and A1A4 Assemblies' cover. Reconnect the correct cable to the 20 MHz OUTPUT on the mainframe A4A4 Assembly.

5-30. 3.95 to 4.05 GHz VCO BIAS ADJUSTMENT

REFERENCE:

Service Sheet 3

DESCRIPTION:

The VCO Bias Adj control sets the bias voltage of the 3.95 to 4.05 GHz oscillator.



Figure 5-4. 3.95 to 4.05 GHz VCO Bias Adjustment Test Setup

EQUIPMENT:

Digital Voltmeter									H	P 34740A/34702A
Extender Cable		•	-		•			•	•	HP 11672-60002

PROCEDURE:

- 1. Remove the top cover from the A1A2 Assembly.
- 2. Connect Digital Voltmeter to pin 2 of A1U2. Refer to the Extension Module Troubleshooting Block Diagram in Section VIII for A1U2 pin locations.
- 3. Adjust the VCO bias potentiometer A1A2R3 for +10.0 Vdc as indicated on the Digital Voltmeter.
- 4. Replace the top cover of the A1A2 Assembly.

5-31. YIG PRETUNE DRIVER ADJUSTMENT

REFERENCE:

Service Sheet 2.

DESCRIPTION:

Adjustments are made to the YIG Pretune Driver controls while the YIG drive voltage and YIG output are monitored by a DVM and an oscilloscope respectively. The GAIN ADJ control sets the range of the YIG drive voltage with the mainframe center frequency set to 0.0 GHz (less significant digits do not affect the adjustment). The digital-to-analog converter controls are then adjusted for specific YIG oscillator output frequencies which correspond to preset center frequencies.



Figure 5-5. YIG Pretune Driver Adjustment Test Setup

EQUIPMENT:

Digital VoltmeterHP 34740A/34702AMicrowave Frequency CounterHP 5340A

PROCEDURE:

1. Prior to installing the A5 YIG Pretune Driver Assembly into the Extension Module, center the adjustment potentiometers so the DVM indicates resistance values in accordance with those listed in Table 5-2. Measure the resistance on the resistance scales of the DVM.

5-31. YIG PRETUNE DRIVER ADJUSTMENT (Cont'd)

Table 5-2. Preliminary Resistance Settings of YIG Pretune Driver Adjustment Potentiometers

Potentiometer	Function	Centered Value
A5R39	Gain Adj	100 Ohms
A5R29	Offset Adj	100 Ohms
A5R13	"1" Adj	1000 Ohms
A5R15	"2" Adj	500 Ohms
A5R17	"4" Adj	250 Ohms
A5R19	"8" Adj	100 Ohms
A5R21	"10" Adj	100 Ohms

- 2. Install the A5 circuit board in the Extension Module (A6 should NOT be installed at this time).
- 3. Connect the microwave frequency counter to the Extension Module output jack J2.
- 4. Set the system center frequency to 0 (zero) GHz.
- 5. Adjust the Gain Adj. control A5R39 for an output frequency from J2 of 3.950 ± 0.001 GHz. Record the frequency to 5 significant digits.

_____ GHz

6. Set the center frequency to 1 GHz and record the J2 output frequency to 5 significant digits.

_____ GHz

- 7. Calculate the difference frequency from the recorded values of steps 5 and 6. If the frequency is 1.0000 ± 0.0005 GHz, proceed to the step 11.
- 8. If the tolerance of the difference frequency is not achieved, set the Offset control A5R29 for a frequency output of 2.950 ± 0.001 GHz. Record the frequency to 5 significant figures.

_____ GHz

9. Set the Center frequency back to 0 (zero) GHz. Record the difference frequency to five significant figures.

_____ GHz

10. Calculate the difference frequency from those recorded in steps 8 and 9. If the frequency difference is 1.0000 ± 0.0005 GHz proceed to step 11. If the difference frequency tolerance is not achieved, repeat steps 5 through 9 until the tolerance is achieved.

NOTE

The following series of adjustments must be performed in the exact manner stated in order to eliminate errors due to YIG hysteresis.

5-31. YIG PRETUNE DRIVER ADJUSTMENT (Cont'd)

- 11. Set the system center frequency to 0 (zero) MHz.
- 12. Set the center frequency to 100 MHz and adjust the appropriate control for the correct output frequency from J2 (refer to Table 5-3). Repeat this process at 200, 400, and 800 MHz ALWAYS INCREASING the frequency to the next setting. Record the frequency to five significant digits.

NOTE

If any one of the "1" through "8" controls needs more range (set full CW or CCW) the "10 Adj" control, which is normally centered, may be reset to bring the frequencies within the required tolerance. (To increase the frequency, the "10 Adj" control A5R21 should be set more CCW.) If the "10 Adj" Control is reset, repeat steps 11 and 12.

Table 5 2	VIC Ducture Dr	ina Digital To Anglog	Convertor Adjustments
<i>Tuble 3-3</i> .	IIG FIELUILE DI	we Digitui-10-Anatog	Convertor Aujustments

Center Frequency (MHz)	Adjust	J2 Output Frequency and Tolerance (GHz)	Actual Frequency in GHz
100	A5R13	3.8500 ± 0.0010	
200	A5R15	3.7500 ± 0.0010	
400	A5R17	3.5500 ± 0.0010	
800	A5R19	3.1500 ± 0.0010	- <u></u>
1100	A5R13	2.8500 ± 0.0010	
1200	A5R15	2.7500 ± 0.0010	

- 13. INCREASE the center frequency to 1100 MHz. If the frequency is close to the tolerance limit or out of tolerance, set the A5R13 control for a frequency closer to the desired frequency shown in Table 5-3.
- 14. Set the center frequency to 0 (zero) MHz; then to 100 MHz. Check the frequency from J2. Knowing how much the frequency changed from the original 100 MHz setting, reset the A6R13 control so the actual frequency is as close to the desired frequency (Table 5-3) as possible for both the 100 and 1100 MHz center frequencies.
- 15. Set the center frequency to 1200 MHz. Repeat steps 13 and 14 for the 200 and 1200 MHz center frequencies.
- 16. Set the system center frequency to 0 MHz, then to the frequencies listed in Table 5-4. Verify the output frequency from J2 is within tolerance. If any of the frequencies are not within tolerance, repeat this entire procedure.

5-31. YIG PRETUNE DRIVER ADJUSTMENT (Cont'd)

Center Frequency (MHz)	YIG Loop Output Frequency From J2 (GHz)
0	3.9500 ± 0.0015
100	3.8500 ± 0.0015
200	3.7500 ± 0.0015
300	3.6500 ± 0.0015
400	3.5500 ± 0.0015
500	3.4500 ± 0.0015
600	3.3500 ± 0.0015
700	3.2500 ± 0.0015
800	3.1500 ± 0.0015
900	3.0500 ± 0.0015
1000	2.9500 ± 0.0015
1100	2.8500 ± 0.0015
1200	2.7500 ± 0.0015

Table 5-4.	Center	Frequency versu	s YIG Loc	op Output
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5-32. YIG LOOP PHASE DETECTOR ADJUSTMENTS

REFERENCE:

Service Sheets 4 and 5.

DESCRIPTION:

The YIG phase lock loop feedback path is opened by removing the 20 MHz signal (which is obtained by mixing and sampling the YIG Oscillator output). The YIG Feedback Loop Gain control is centered, the Phase Ref Adj control is set to trigger the search signal on, and the DC Offset Adj centers the search waveform about 0 Vdc. The feedback path is closed and the Offset Adj on the YIG Pretune Driver Assembly sets the locked search output (a dc level) as close to ground potential as possible. The phase Adj control is set to obtain 90° phase shift between the 20 MHz REF signal and the 20 MHz IF signal. (The quadrature phase detector output is at a maximum negative dc level at 90° phase shift).

The 4.43 GHz Oscillator frequency control is readjusted to obtain a 3.95 GHz output from the YIG Oscillator with the center frequency set to 0.0 GHz (less significant digits do not affect the adjustment).

5-32. YIG LOOP PHASE DETECTOR ADJUSTMENTS (Cont'd)



Figure 5-6. YIG Loop Phase Detector Adjustment Test Setup

EQUIPMENT:

Microwave Freque	ncy	, C	our	nter		•		•					•			HP	5340A
Oscilloscope	•		•	•	•				•		•	HP	180)A/	180	D1A	/1821A
10:1 Divider Probe	•		•	•	•	•	•	٠	•	•	•	•	•	•	•	HP	10004

PROCEDURE:

- 1. Connect YIG FM Driver board assembly A6 to an extender board and insert into the Extension Module.
- 2. Adjust YIG loop gain potentiometer A7R20 to the center of its range.
- 3. Insert the YIG Loop Phase Detector board assembly A7 into place.
- 4. Connect oscilloscope probe to A7TP1 and adjust A7C2 for most negative dc voltage (typically -10.0 Vdc) as observed on the oscilloscope.
- 5. Disconnect 20 MHz output cable W4 from A1J4.
- 6. Connect oscilloscope probe to A6TP1. Adjust oscilloscope to display a triangular waveform of approximately 2.5 volts peak-to-peak with a period of approximately 1.5 milliseconds. If waveform is not present, rotate potentiometer A7R17 ccw, and then, cw as necessary to turn search waveform generator (located on A6) on. When search waveform generator is turned on, oscilloscope should display typical waveform illustrated in Figure 5-6.
- 7. Adjust potentiometer A7R17 until search waveform generator is just triggered to produce waveform illustrated in Figure 5-6.

ADJUSTMENTS

5-32. YIG LOOP PHASE DETECTOR ADJUSTMENTS (Cont'd)

- 8. Adjust DC Offset potentiometer A6R6 so triangular search waveform is centered across 0 Vdc reference line on oscilloscope.
- 9. Reconnect 20 MHz output cable W4 A1J4. The triangular waveform displayed on oscilloscope should change to 0 ± 0.5 Vdc.
- 10. Set the system center frequency to 0 (zero) MHz. Then step the frequency in 100 MHz steps to 1200 MHz and verify correct adjustment of A7R17, (that the loop remains locked). If loop unlocks or false locks, slightly readjust A7R17 cw until loop again locks at all frequencies (0 to 1200 MHz in 100 MHz steps). Then turn A7R17 1/8 turn cw for safety margin.

NOTE

When false lock occurs, the output is locked and stable but the output frequency is incorrect.

- 11. Set the center frequency to 0 (zero) MHz. Then step the frequency in 100 MHz steps to 1200 MHz to verify that loop remains locked at all frequencies. If loop unlocks or false locks readjust A7R17 cw until loop again locks.
- 12. Set the center frequency to 0 (zero) MHz. While monitoring the YIG loop output at J1 with frequency counter, adjust R1 so the YIG loop output frequency is 3.9500 ± 0.0005 GHz.
- 13. Set the center frequency to 0 (zero) MHz and then to 1200 MHz while monitoring dc level at A6TP1. Adjust offset potentiometer A5R29 for best compromise setting that makes A6TP1 level as close to 0 volts as possible for all center frequency settings of 0 to 1200 MHz (100 MHz steps).

5-33. YIG LOOP GAIN AND BANDWIDTH ADJUSTMENT

REFERENCE:

Service Sheet 4

DESCRIPTION:

To simulate frequency modulation, a manually swept 19 to 21 MHz signal is superimposed on the 20 MHz second IF signal. The output signal from the RF Section plug-in is monitored by a Spectrum Analyzer. The YIG loop Gain is set for the maximum flatness across the 1 MHz bandwidth.

5-33. YIG LOOP GAIN AND BANDWIDTH ADJUSTMENT (Cont'd)



Figure 5-7. YIG Loop Gain and Bandwidth Adjustment Test Setup

EQUIPMENT:

VHF Oscillator								•					HP 8654A
Step Attenuator (10 dB)			•	•	•			•				•	HP 355D
Spectrum Analyzer	•	•	•	•	•	•	•	•	HP	853	55A	/85	552B/140T

PROCEDURE:

- 1. Interconnect equipment as illustrated in Figure 5-7. The TEE connection is made as follows:
 - a. disconnect W4 from A1J4.
 - b. connect W4 to one port of TEE connector.
 - c. connect one port of TEE connector to A1J4.
 - d. connect variable attenuator to remaining port of TEE connector.
- 2. Set Step Attenuator for 60 dB attenuation.
- 3. Adjust VHF Oscillator output to 19 MHz and set output Vernier to mid-range.
- 4. Adjust Synthesized Signal Generator mainframe and RF Section output to 400 MHz at -10 dBm.
- 5. Calibrate Spectrum Analyzer to make attenuation measurement.

ADJUSTMENTS

5-33. YIG LOOP GAIN AND BANDWIDTH ADJUSTMENT (Cont'd)

- 6. Adjust Spectrum Analyzer for logarithmic display of 400 MHz fundamental plus both sidebands out to 500 kHz from fundamental. Adjust Spectrum Analyzer as follows: BANDWIDTH, 10 kHz; SCAN WIDTH, 200 kHz; SCAN TIME, 5 microseconds; and INPUT ATTENUATION, 20 dB. Use Spectrum Analyzer level controls to adjust display so fundamental peak is near top reference level line.
- 7. Vary signal generator output frequency from 19 to 21 MHz.
- 8. Adjust YIG loop gain potentiometer A7R20 until flatness of sidebands (about 40 dB below fundamental) is ≤ 3 dB within ± 500 kHz of fundamental. Refer to Figure 5-7 for illustration of typical waveform.

5-34. SUM LOOP PRETUNE ADJUSTMENT

REFERENCE

Service Sheet 6

DESCRIPTION:

The Sum Loop PHase Error output voltage is set by adjusting the Sum Loop Pretune resistance ladder controls (part of the digital-to-analog convertor).



Figure 5-8. Sum Loop Pretune Adjustment Test Setup

EQUIPMENT:

PROCEDURE:

- 1. Install Sum Loop Phase Detector board assembly A3 into the Extension Module.
- 2. Center all adjustment potentiometers, including "B" potentiometer, on the A4 Assembly.
- 3. Connect the A4 Assembly circuit board to an extender board and install it into the Extension Module.
- 4. Connect Digital voltmeter to A3TP1.

5-34. SUM LOOP PRETUNE ADJUSTMENT (Cont'd)

- 5. Set Synthesized Signal Generator System center frequency to 5 MHz and adjust A4R5 for a voltage at A3TP1 of +10.0 ± 1.0 Vdc.
- 6. Set the center frequency in 10 MHz steps from 5 to 95 MHz. Adjust appropriate potentiometer for +10.0 volts level at A3TP1 in accordance with Table 5-5. Adjust potentiometers as close to +10.0 volts as possible.

Center Frequency (MHz)	Potentiometer	Function	A3TP1 Level*
05	A4R5	0 Adj	+10.0 ± 1.0 volts
15	A4R11	1 Adj	+10.0 \pm 1.0 volts
25	A4R16	2 Adj	$+10.0 \pm 1.0$ volts
35	A4R20	3 Adj	+10.0 ± 1.0 volts
45	A4R23	4 Adj	$+10.0 \pm 1.0$ volts
55	A4R26	5 Adj	+10.0 ± 1.0 volts
65	A4R29	6 Adj	+10.0 ± 1.0 volts
75	A4R32	7 Adj	$+10.0 \pm 1.0$ volts
85	A4R35	8 Adj	+10.0 ± 1.0 volts
95	A4R38	9 Adj	+10.0 ± 1.0 volts
95 *If the range of any of the control the 3.95 to 4.05 GHz VCO Adjus	A4R38	9 Adj	+10.0 ± 1.0 vol

Table 5-5. Sum Loop Pretune Potentiometer Adjustment

7. Repeat step 6 to verify that all adjustments are within voltage level tolerance.

5-35. SUM LOOP BANDWIDTH ADJUSTMENT

REFERENCE:

Service Sheets 3 and 6.

DESCRIPTION:

A Spectrum Analyzer is used to monitor the RF Section RF OUTPUT while a 25 MHz phase-modulated (100 kHz to 1 MHz) signal is injected at the 20 to 30 MHz input on the Frequency Extension Module. "0" potentiometer A4R5 is adjusted to obtain a 3 dB bandwidth of 500 kHz \pm 150 kHz, as observed on the Spectrum Analyzer. Then, "B" potentiometer A4R6 is adjusted to maintain approximately +10 volts at A3TP1. The phase-modulated 25 MHz signal is removed from the 20 to 30 MHz input and 20 to 30 MHz signal from the mainframe is reconnected. With the mainframe center frequency set to 1.005 GHz, potentiometer R1 is adjusted to vary the 4.43 GHz oscillator frequency until the VCO output frequency is 3.9550 ± 0.0001 GHz. The "B" potentiometer A4R6 is readjusted to obtain +10.0 \pm 1.0 volts at A3TP1. Finally, the center frequency is stepped from 1.005 GHz to 1.095 GHz in 0.01 GHZ (10 MHz) steps and the appropriate potentiometers listed in Table 5-5 are set to maintain the A3TP1 voltage at +10.0 Vdc at each frequency.

5-35. SUM LOOP BANDWIDTH ADJUSTMENT (Cont'd)



Figure 5-9. Sum Loop Bandwidth Adjustment Test Setup

EQUIPMENT:

Test Oscillator		•											. H	P 651E
Spectrum Analyzer		•							HP	85	55 <i>I</i>	4/8	552E	3/140T
Microwave Frequency Count	ter		•				•	•		•	•		HP	5340A
Oscilloscope	•	•	•	•				•	HP	18	0A/	180)1A/	1821A
10:1 Divider Probe	•	•	•	•	•		•			•	•	•	HP	10004
Frequency Synthesizer	•	•	•	•	•	•	•	•	•	•	HP	510)5A/	/5110E

PROCEDURE:

- 1. Interconnect equipment as illustrated in Figure 5-9.
- 2. Remove left side cover from mainframe and disconnect white/orange cable W23 from the A2 Assembly connector in mainframe.
- 3. Connect Frequency Synthesizer (5105A) output to W23.

ADJUSTMENTS

5-35. SUM LOOP BANDWIDTH ADJUSTMENT (Cont'd)

- 4. Connect Test Oscillator 50 Ohm output to Phase Modulation input on rear panel of Frequency Synthesizer (5105A).
- 5. Place the A4 Assembly on an extender board and insert it into A2XA4.
- 6. Adjust the Frequency Synthesizer (5105A) for a 25.000000 MHz output. The VERNIER should be in CAL. position.
- 7. Adjust Test Oscillator for a 100 kHz output frequency at -30 dBm.
- 8. Set mainframe center frequency to 1.095 GHz, RF Section OUTPUT RANGE switch to 0 dBm, and adjust VERNIER for a 0 dB indication on meter scale.
- 9. Adjust Spectrum Analyzer as follows: FREQUENCY, 1.095 GHz; BANDWIDTH, 30 kHz; SCAN WIDTH, 0.2 MHz/div.; SCAN TIME, 1 mSec/div.; INPUT ATTENUATION, 20 dB; LOG REF, 10 dBm; VIDEO FILTER, OFF; SCAN MODE, INT; TRIGGER, AUTO; MODE, 10 dB LOG.
- 10. Vary Test Oscillator output frequency from 100 kHz to 1 MHz and observe sidebands displayed on Spectrum Analyzer. Sidebands should be down 3 dB at 500 kHz ± 150 kHz. If 3 dB bandwidth of sidebands is not within 500 ± 150 kHz of carrier, select A4C8 value for correct response. Normal range of A4C8 value is 200 pF to 330 pF (increasing capacitance increases bandwidth).
- 11. Set mainframe center frequency to 1.005 GHz.
- 12. Adjust Spectrum Analyzer FREQUENCY to 1.005 GHz.
- 13. Connect Oscilloscope to A3TP1.
- 14. Vary Test Oscillator output frequency from 100 kHz to 1 MHz and observe sidebands displayed on Spectrum Analyzer. Adjust "0" potentiometer A4R5 to obtain a sideband 3 dB bandwidth of 500 ± 150 kHz. In order to meet bandwidth requirements it may be necessary to adjust "B" potentiometer A4R6 for +10.0 ± 1.0 volts as indicated on Oscilloscope.
- 15. Adjust "B" potentiometer A4R6 for +10.0 ± 1.0 volts at A3TP1, as indicated on Oscilloscope.
- 16. Disconnect white/orange cable W12 from Frequency Synthesizer (5105A) output and reconnect white/orange cable to the jack on the A2 Assembly in the mainframe.
- 17. Disconnect gray cable from J1. Connect Microwave Frequency Counter to Sum Loop Output con-J1.
- 18. Adjust potentiometer R1 to vary the 4.43 GHz oscillator frequency until the Sum Loop Output frequency is 3.9550 ± 0.0001 GHz as indicated on Digital Frequency Counter. Disconnect Microwave Frequency Counter from J1 and reconnect gray cable.
- 19. Adjust "B" potentiometer A4R6 to obtain +10.0 ± 1.0 volts at A3TP1, as indicated on Oscilloscope.
- 20. Step the center frequency from 1.005 to 1.095 GHz in 0.01 GHz (10 MHz) steps. Adjust appropriate potentiometer for +10.0 Vdc at A3TP1 in accordance with Table 5-5.

SECTION VI REPLACEABLE PARTS

6-1. INTRODUCTION

6-2. This section contains information for ordering replacement parts for the HP Model 11661A Frequency Extension Module. Table 6-1 lists abbreviations used in the parts list and throughout the manual. Table 6-2 lists all replaceable parts in reference designator order. Table 6-3 contains the names and addresses that correspond to the manufacturer's code number.

6-3. ABBREVIATIONS

6-4. Table 6-1 gives a list of abbreviations used in the parts list, schematics, and throughout the manual. In some cases, two forms of the abbreviations are given, one all capital letters and one partial or no capitals. This occurs because the abbreviations in the parts list are always all capitals. However, in the schematics and other parts of the manual, other abbreviation forms are used with both lower case and upper case letters.

6-5. REPLACEABLE PARTS LIST

6-6. Table 6-2 is the list of replaceable parts and is organized as follows:

a. Electrical assemblies and their components in alpha-numeric order by reference designation.

b. Chassis-mounted parts in alpha-numeric order by reference designation.

- c. Miscellaneous parts.
- d. Illustrated parts breakdown.

The information given for each part consists of the following:

a. The Hewlett-Packard part number.

b. The total quantity (Qty) used in the instrument.

c. The description of the part.

d. Typical manufacturer of the part in a five-digit code.

e. Manufacturer code number for the part.

The total quantity for each part is given only once; at the first appearance of the part number in the list.

6-7. ORDERING INSTRUCTIONS

6-8. To order a part listed in the replaceable parts table, quote the Hewlett-Packard part number, indicate quantity required, and address the order to the nearest Hewlett-Packard office.

6-9. To order a part that is not listed in the replaceable parts table, include the instrument model number, instrument serial number, the description and function of the part, and the number of parts required. Address the order to the nearest Hewlett-Packard office.

6-10. PARTS PROVISIONING

6-11. Stocking spare parts for an instrument is often done to insure quick return to service after a malfunction occurs. Hewlett-Packard has a "Spare Parts Kit" available for this purpose. The kit consists of selected replaceable assemblies and components for this instrument. The contents of the kit and the "Recommended Spares" list are based on failure reports and repair data, and parts support for one year. A complimentary "Recommended Spares" list for this instrument may be obtained on request, and the "Spare Parts Kit" may be ordered through your nearest Hewlett-Packard office.

Table 6-1. Reference Designations and Abbreviations (1 of 2)

REFERENCE DESIGNATIONS

A assembly
AT attenuator; isolator;
termination
B fan; motor
BT battery
C capacitor
CP coupler
CR diode; diode
thyristor; varactor
DC directional coupler
DL delay line
DS annunciator;
signaling device
(audible or visual);
lamp; LED
-

E miscellaneous electrical part
Ffuse FLfilter Hhardware HYcirculator Jelectrical connector (stationary portion); jack
K relay

mechanical part

COEF coefficient

rb	પ્ર
H hardware	
HY circulator	R
J electrical connector	R
(stationary portion);	S
jack	Т
	T
K relay	T
L coil; inductor	T
M meter	
MP miscellaneous	
mechanical part	

P electrical connector (movable portion);
Q transistor: SCR; triode thyristor
R
TBterminal boardTCthermocoupleTPtest point

EDP electronic data

U integrated circuit;
V electron tube
VR voltage regulator;
breakdown diode
W cable; transmission
path; wire
X socket
Y crystal unit (piezo-
electric or quartz)
Z tuned cavity; tuned
circuit

ABBREVIATIONS

A ampere
ac alternating current
ACCESS accessory
ADJ adjustment
A/D analog-to-digital
AF audio frequency
AFC automatic
frequency control
AGC automatic gain
control
AL aluminum
ALC automatic level
control
AM amplitude modula-
tion
AMPL amplifier
APC automatic phase
control
ASSY assembly
AUX auxiliary
avg average
AWG American wire
gauge
gauge BAL balance
gauge BAL balance BCD binary coded
BAL balance BCD binary coded decimal
gauge BAL balance BCD binary coded decimal BD board
gauge BAL balance BCD binary coded decimal BD board BE CU beryllium
BAL balance BCD binary coded decimal BD board BE CU beryllium copper
BAL balance BCD binary coded decimal BD board BE CU beryllium copper BFO beat frequency
BAL balance BCD binary coded decimal BD board BE CU beryllium copper BFO beat frequency oscillator
gauge BAL balance BCD binary coded decimal BD binary coded BE CU beard BFO beard BFO beat frequency oscillator BH
gauge BAL balance BCD binary coded decimal BD board BE CU beryllium copper BFO beat frequency oscillator BH binder head BKDN breakdown
gauge BALbalance BCDbinary coded decimal BDboard BE CUberyllium copper BFObeat frequency oscillator BHbinder head BKDNbreakdown BP BFbinder head
gauge BALbalance BCDbinary coded decimal BDboard BE CUboard BE CUbeat beryllium copper BFObeat frequency oscillator BHbinder head BKDNbinder head BPFbandpass BPFbandpass filter
gauge BALbalance BCDbinary coded decimal BDboard BE CUboard BE CUbeat beryllium copper BFObeat frequency oscillator BHbinder head BKDNbreakdown BPbandpass BPFbandpass filter BRSbrass
gauge BAL binary coded BCD binary coded decimal BD binary coded BE CU beat copper BFO beat frequency oscillator BH binder head BKDN breakdown BP bandpass BPF bandpass BWO brass
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gauge BALbinary coded BCDbinary coded decimal BDbinary coded decimal BDbinary coded decimal BDbinary coded decimal BDbinary coded copper BFObeat frequency oscillator BHbinder head BKDNbreakdown BPFbandpass filter BRSbrass BWObackward-wave oscillator CALcalibrate ccwcounter-clockwise CERceramic CHANchannel cmcentimeter
gauge BAL binary BCD binary BCD binary coper board BFO beryllium copper browner BH binder head BKDN breakdown BP breakdown BP bandpass BVO backward-wave oscillator calibrate CAL calibrate ccw counter-clock wise CER ceramic CHAN channel cm calibrate cMO cabinet mount only

COM common
COMP composition
COMPL complete
CONN connector
CP cadmium plate
CRT cathode-ray tube
CTL complementary
transistor logic
CW continuous wave
cw clockwise
cm centimeter
D/A digital-to-analog
dB decibel
dBm decibel referred
to 1 mW
dc direct current
deg degree (temperature
interval or differ-
o ence)
degree (plane
o angle)
C degree Celsius
o (centigrade)
F degree Fahrenheit
K degree Kelvin
DEPC deposited carbon
DET detector
diam diameter
DIA diameter (used in
parts list)
DIFF AMPL differential
amplifier
div division
DPDT double-pole,
double-throw
DR drive
DSB double sideband
DTL diode transistor
logic
DVM digital voltmeter
ECL emitter coupled
logic
EMF electromotive force

ĩ	processing
ELECT .	electrolytic
ENCAP .	encapsulated
ЕХТ	external
F	farad
FET	field-effect
*	ransistor
F/F	flip-flop
г/г Би	flat bood
FH	filliotor bood
	innster head
FM Ire	quency modulation
	iront panel
FREQ	irequency
FXD	lixed
g	gram
GE	germanium
GHz	gigahertz
GL	
GRD	ground(ed)
н	henry
h	hour
нет	heterodyne
HEX	hexagonal
HD	
HDW .	hardware
HF	high frequency
HG	mercury
ні	high
HP	. Hewlett-Packard
HPF	high pass filter
HR	hour (used in
Γ	parts list)
ну	high voltage
Hz	Hertz
10	integrated circuit
ID .	inside diameter
IF	intermediate
f	requency
IMPG	impregnated
in	inch
INCD	incandescent
INCL	include(s)
INP	innut
ING	insulation
	···· ··· Insulation

INT internal
kg kilogram
kHz kilohertz
$k\Omega$ kilohm
kV kilovolt
lb pound
LC inductance-
capacitance
LED light-emitting diode
LE low frequency
LG long
III left hand
LIM limit
LIN brook toper (used
LIN Inear taper (used
in parts list)
lin linear
LK WASH lock washer
LO low; local oscillator
LOG logarithmic taper
(used in parts list)
log logrithm(ic)
LPF low pass filter
LV low voltage
m meter (distance)
mA milliampere
MAX maximum
$M\Omega$ megohm
MEG meg (10^6) (used
in parts list)
MET FLM metal film
MET OX metallic oxide
MF medium frequency:
microfored (used in
ninciolarad (used in
MED manufacturor
MFR manufacturer
mg muligram
MHz meganertz
mH mullhenry
mho mho
MIN niinimum
min minute (time)
' minute (plane
angle)
MINAT miniature
mm millimeter
MOD modulator

MOM momentary
MOS metal-oxide
semiconductor
ms millisecond
MTG mounting
MTR meter (indicating
device)
mV millivolt
mVac millivolt, ac
mVdc millivolt, dc
mVpk millivolt, peak
mVp-p millivolt, peak-
to-peak
mVrms millivolt, rms
mW milliwatt
MUX multiplex
MY mylar
μA microampere
μF microfarad
μΗ microhenry
µmho micromho
μs microsecond
μV microvolt
μ Vac microvolt, ac
μ Vdc microvolt, dc
μ Vpk microvolt, peak
μ Vp-p microvolt, peak-
to-peak
μ Vrms microvolt, rms
μ W microwatt
nA nanoampere
NC no connection
N/C normally closed
NE neon
NEG negative
nF nanotarad
NI PL nickel plate
N/U normaily open
NOM nominal
NORM normal
NPN negative-positive-
NBO pogetive positive
NFO negative-positive
ture coefficient)
NPEP not recommended
for field replace
ment
NCB not constably
ron not separately
ne nepiaceable
nw nanosecond
OBD order by descrip-
tion
0011

Table 6-1. Reference Designations and Abbreviations (2 of 2)

OD outside diameter
OH oval head
OP AMPL operational
amplifier
OPT option
OSC oscillator
OX oxide
oz
Ω ohm
P peak (used in parts
list)
PAM pulse-amplitude
modulation
PC printed circuit
PCM pulse-code modula-
tion; pulse-count
PDM pulse-duration
modulation
pr picolarad
PH BRZ phosphor bronze
PHL Philips
PIN positive-intrinsic-
voltage
nk peak
PL
PLO phase lock
oscillator
PM phase modulation
PNP positive-negative-
positive
P/O part of
POLY polystyrene
PORC porcelain
POS positive; position(s)
(used in parts list)
POSN nosition
Cont position
POT potentiometer
POT potentiometer p-p peak-to-peak
POT potentiometer p-p peak-to-peak PP peak-to-peak (used
POT potentiometer p-p peak-to-peak PP peak-to-peak (used in parts list)
POT potentiometer p-p peak-to-peak PP peak-to-peak (used in parts list) PPM pulse-position
POT potentiometer p-p peak-to-peak PP peak-to-peak (used in parts list) PPM pulse-position modulation
POT potentiometer p-p peak-to-peak PP peak-to-peak (used in parts list) PPM pulse-position modulation PREAMPL preamplifier
POT potentiometer p-p peak-to-peak PP peak-to-peak (used in parts list) PPM pulse-position modulation PREAMPL preamplifier PRF pulse-repetition
POT potentiometer p-p peak-to-peak PP peak-to-peak (used in parts list) PPM pulse-position modulation PREAMPL preamplifier PRF pulse-repetition frequency
POT potentiometer p-p peak-to-peak PP peak-to-peak (used in parts list) PPM pulse-position modulation PREAMPL preamplifier PRF pulse-repetition frequency PRR pulse repetition
POT potentiometer p-p peak-to-peak PP peak-to-peak (used in parts list) PPM pulse-position modulation PREAMPL preamplifier PRF pulse-repetition frequency PRR pulse repetition rate
POT potentiometer p-p peak-to-peak PP peak-to-peak (used in parts list) PPM pulse-position modulation PREAMPL preamplifier PRF pulse-repetition frequency PRR pulse repetition rate ps picosecond
POT potentiometer p-p peak-to-peak PP peak-to-peak (used in parts list) PPM pulse-position modulation PREAMPL preamplifier PRF pulse-repetition frequency PRR pulse repetition rate ps picosecond PT point
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POT potentiometer p-p potentiometer p-p peak-to-peak PP peak-to-peak (used in parts list) PPM pulse-position modulation PREAMPL preamplifier PRF pulse-repetition frequency PRR pulse repetition rate ps picosecond PT pulse-time modulation PWM pulse-width PMM pulse-width

 PWV peak working voltage RC resistance-capacitance RECT restifier REF redifier REF replaceable RF radio frequency RFI radio frequency RFI radio frequency RFI radio frequency RFI round head; right hand RLC resistance-inductance-capacitance RMO rack mount only rms root-mean-square RND round ROM read-only memory R&P rack and panel RWV reverse working voltage S second (time) second (time) second (time) S-B slow-blow (fuse) (used in parts list) SCR silicon controlled rectifier; screw SE superhigh frequency SIL silicon SIL single-pole, double-throw SPG single-sideband SST single sideband SST stainless steel STL single sideband SST stainless steel STL stainless steel STL stainless steel STL stainless steel ST steel SQ synchronize T timed (slow-blow fuse) TA tantalum 		
RC resistance- capacitance RECT rectifier REF regulated REPL replaceable RF radio frequency Interference RH round head; right hand RLC resistance- inductance- capacitance RMO rack mount only rms root-mean-square RND round ROM read-only memory R&P rack and panel RWV reverse working voltage S scattering parameter s second (time) " second (plane angle) S-B slow-blow (fuse) (used in parts list) SCR slicon controlled rectifier; screw SE sections SEMICON semicon- ductor SHF superhigh fre- quency SI silicon SIL silicon SIL silicon SIL silicon SPDT single-pole, double-throw SSB single sideband SST stainless steel ST stainless steel ST stainless steel ST stainless steel ST single sideband SST stainless steel ST steel SQ synchronize T timed (slow-blow fuse) TA tantalum TC temperature compensating	PWV.	peak working
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SPG		double-throw
SR	SPG .	
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SWR standing-wave ratio SYNC synchronize T timed (slow-blow fuse) TA tantalum TC temperature compensating	sq	square
SYNC synchronize T timed (slow-blow fuse) TA tantalum TC temperature compensating compensating	SWR .	. standing-wave ratio
T timed (slow-blow fuse) TA tantalum TC temperature compensating	SYNC	synchronize
TA tantalum TC temperature compensating	T ti	med (slow-blow fuse)
TC temperature compensating	ТА	tantalum
compensating	тс	temperature
		compensating

TD time delay
TERM terminal
TFT thin-film transistor
IGL toggie
THD thread
THRU through
TI titanium
TOL tolerance
TRIM trimmer
TSTR transistor
TTL transistor-transistor
logia
logic
TV television
TVI television interference
TVT television interference
TWT traveling wave tube
$U_{1}, \dots, micro(10^{0})$ (used)
in parts list)
III parts list)
UF microfarad (used in
parts list)
UHF ultranigh frequency
UNREG unregulated
V volt
V
VA voltampere
Vac
VAD
VAR
VCO voltage-controlled
oscillator
Vda sola da
vac volts, ac
VDCW. volts, dc, working
(used in parts list)
(used in pures hat)
V(F) Volts, nitered
VFO variable-frequency
oscillator
VHF very-nigh fre-
quency
Vok volte peak
Vph
vp-p., voits, peak-to-peak
Vrms volts, rms
VSWR voltage standing
vonate vonage standing
wave ratio
VTO voltage-tuned
orgillator
OSCILIATOR
VTVM vacuum-tube
voltmeter
V(V) volta auto-hod
V(A) Volts, switched
W
W/ with
WTW
wiv working inverse
voltage
WW wirewound
w/U without
YIG yttrium-iron-garnet
7 characteristic
o · · · · · · · · · · · · · · · · · · ·
impedance

NOTE

All abbreviations in the parts list will be in upper-case.

MULTIPLIERS

Abbreviation	Prefix	Multiple
т	tera	1012
G	giga	10 ⁹
М	mega	106
k	kilo	10 ³
da	deka	10
d	deci	10-1
c	centi	10^{-2}
m	milli	10-3
ш	micro	10-6
'n	nano	10 ⁻⁹
D	pico	10-12
f	femto	10-15
a	atto	10-18

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
	11661-60019	,		28480	11661-60019
A1C1 A1C2 A1C3 A1C4 A1C5	0150-2437 0160-2437 0160-2437 0160-2437 0160-2437 0160-4023 0360-1155	6 1 2	CAPACITOR-FXD 5000PF +80-203 200WVDC CER CAPACITOR-FXD 5000PF +80-203 200WVDC CER CAPACITOR-FXD 5000PF +80-203 200WVDC CER CAPACITOR-FXD 5000PF +80-203 200WVDC CER CAPACITOR-FXD 680PF +-203 500WVDC CER TERMINAL, SLOR LUG, 12 SCR, -25/-093 ID	28480 28480 28480 28480 28480 28480 79963	0160-2437 0160-2437 0160-2437 0160-2437 0160-2437 0160-4023 110
A1C6 A1C7	0160-2437 0160-2437		CAPACITOR-FXD 5000 PF +80-20% 200WVDC CER CAPACITOR-FXD 5000 PF +80-20% 200WVDC CER	28480 28480	0160-2437 0160-2437
A1J1 A1J2 A1J3 A1J4 A1J5	1250-0901 1250-0901 1250-0901 1250-0901 1250-0901 1250-0901	7	CONNECTOR-RF SMB M SGL HOLE FR CONNECTOR-RF SMB M SGL HOLE FR	2K 497 2K 497 2K 497 2K 497 2K 497 2K 497	700166 700166 700166 700166 700166 700166
A1J6 A1J7	1250- 0901 1250- 0901		CONNECTOR-RF SMB M SGL HOLE FR Connector-RF SMB M SGL HOLE FR	2K 49 7 2K 49 7	700166 700166
A 1 F 1 A 1 P 2 A 1 R 3	0757-0401 0698-7192 0698-7217	3 1 2	RESISTOR 100 OHM 1% .125W F TUBULAR RESISTOR 14.7 OHM 2% .05W F TUBULAR RESISTOR 162 OHM 2% .05W F TUBULAR	24546 24546 24546	C4-1/8-T0-101-F C3-1/8-T00-14R7-G C3-1/8-T0-162R-G
A 1U 1 A 1U 2 A 1U 3	5086- 7055 5086- 7054 5086- 7053	1 1 1	SAMPLER, 1.8 GHZ LOW PASS FILTER ASSY VCO/MIXER ASSY 4.43 GHZ OSC/MIXER ASSY	28480 28480 28480	5086-7055 5086-7054 5086-7053
			A1 MISCELLANEOUS		
	0360-1155 11661-09004 11661-09006 11661-09016 11661-09008	1 2 1 1	TERMINAL, SLDR LUG, 12 SCR, .25/.093 ID COVER, SUM LOOP CLAMP,MICROCIRCUIT OSCILLATOR COVER, FILTER CLMP, SAMPLER-FILTER	79963 28480 28480 28480 28480 28480	110 11661-00004 11661-00006 11661-00016 11661-00008
	11661-00009 0380-0793	1 2	COVER, YIG LOOP SPACER-RND .156-LG .093-ID .125-OD BRS	28480 76854	11661-000 09 15525-610
A1A1	11661-60007	1	20 MHZ IF AMPLIFIER ASSY	28480	11661-60007
A1A1C1 A1A1C2 A1A1C3 A1A1C3 A1A1C4 A1A1C5	0121-0448 0160-3878 0160-3878 0160-3878 0160-3878 0160-3879	1 10 18	CAPACITOR; VAR; TRMR; CER; 2.5/5PF CAPACITOR=FXD 1000PF +-20% 100WVDC CER CAPACITOR=FXD 1000PF +-20% 100WVDC CER CAPACITOR=FXD 1000PF +-20% 100WVDC CER CAPACITOR=FXD .01UF +-20% 100WVDC CER	00865 28480 28480 28480 28480 28480	55-TRIKO-03, 2.5 0160-3878 0160-3878 0160-3878 0160-3878 0160-3879
A1A1C6 A1A1C7 A1A1C8 A1A1C9	0 160-3879 0 160-3879 0 160-3879 0 160-3879		CAPACITOR-FXD ₀01UF ↔ 20% 100WVDC CER CAPACITOR-FXD ₀01UF ↔ 20% 100WVDC CER CAPACITOR-FXD ₀01UF ↔ 20% 100WVDC CER CAPACITOR-FXD ₀01UF ↔ 20% 100WVDC CER	28480 28480 28480 28480 28480	0160-3879 0160-3879 0160-3879 0160-3879
A1A1CR1	1901-0040	11	DIDDE-SWITCHING 2NS 30V 50MA	28480	1901-0040
A 1A 1L 1 A 1A 1L 2 A 1A 1L 3 †	9140-0144 9100-1618 9140-0144	5 1	COIL; FXD; MOLDED RF CHOKE; 4.7UH 10% COIL; FXD; MOLDED RF CHOKE; 5.6UH 10% COIL; FXD; MOLDED RF GWOKE; 4.7UH 10%	24226 24226 24226	10/471 15/561 10/471
A 1A 101 A 1A 102 A 1A 103	1853-0015 1854-0009 1855-0081	1 1 1	TRANSISTOR PNP SI CHIP PD=200MW TRANSISTOR NPN 2N709 SI TO-18 PD=300MW TRANSISTOR; J-FET N-CHAN, D-MODE SI	28480 28480 01295	1853-0015 1854-0009 2N5245
A 1A 1R1 A 1A 1R2 A 1A 1R3 A 1A 1R3 A 1A 1R4 A 1A 1R5	0698-7260 0698-7236 0698-7243 0698-7212 0698-7212	7 11 5 6	RESISTOR 10K 2% .05W F TUBULAR RESISTOR 1K 2% .05W F TUBULAR RESISTOR 1.96K 2% .05W F TUBULAR RESISTOR 100 OHM 2% .05W F TUBULAR RESISTOR 1.96K 2% .05W F TUBULAR	24546 24546 24546 24546 24546 24546	C3-1/8-T0-1002-G C3-1/8-T0-1001-G C3-1/8-T0-1961-G C3-1/8-T0-100R-G C3-1/8-T0-1961-G
A 1A 1R 6 A 1A 1R 7 A 1A 1R 8 A 1A 1R 9 A 1A 1R 10	0698-7247 0698-7195 0698-7234 0698-7219 0698-7245	2 2 1 8 2	RESISTOR 2.87K 2% .05W F TUBULAR RESISTOR 19.6 DHM 2% .05W F TUBULAR RESISTOR 825 DHM 2% .05W F TUBULAR RESISTOR 196 DHM 2% .05W F TUBULAR RESISTOR 2.37K 2% .05W F TUBULAR	24546 24546 24546 24546 24546	C3-1/8-T0-2871-G C3-1/8-T00-19R6-G C3-1/8-T0-825R-G C3-1/8-T0-196R-G C3-1/8-T0-2371-G
A 1A 1R 11	0698-7205	3	RESISTOR 51.1 OHM 2% .05W F TUBULAR	24546	C 3-1/8-T00-51R1-G
A142	11661-60008	1	380-480 MHZ IF AMPLIFIER ASSY	28480	11661-60008
A 1A 2C1 A 1A 2C2 A 1A 2C3 A 1A 2C4 A 1A 2C5	0180-0197 0180-1746 0160-3878 0160-2266 0160-2266	7 1 2	CAPACITOR-FXD; 2.2UF+-10% 20VDC TA CAPACITOR-FXD; 15UF+-10% 20VDC TA-SOLID CAPACITOR-FXD 1000PF +-20% 100WDC CER CAPACITOR-FXD 24PF +-5% 500WVDC CER 0+ CAPACITOR-FXD 24PF +-5% 500WVDC CER 0+	56289 56289 28480 28480 28480 28480	150D225X9020A2 150D156X9020B2 0160-3878 0160-2266 0160-2266
A1A2C6 A1A2C7 A1A2C8	0 160- 38 78 0 160- 38 78 0 160- 22 57	1	CAPACITOR-FXD 1000PF +-20% 100WVDC CER CAPACITOR-FXD 1000PF +-20% 100WVDC CER CAPACITOR-FXD 10PF +-5% 500WVDC CER 0+	28480 28480 28480	0160-3878 0160-3878 0160-2257

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Table 6-2. Replaceable Parts

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
A 1 A 2L 1 A 1 A 2L 2 A 1 A 2L 3	9140-0144 08660-80009 08660-80009	2	COIL; FXD; MOLDED RF CHOKE; 4.7UH 10% Inductor Inductop	24226 28480 28480	10/471 08660-80009 08660-80009
A 1A 2017 A 1A 202	1854-0540 1854-0540	2	TRANSISTOR NPN SI TO-72 PD=200MW TRANSISTOR NPN SI TO-72 PD=200MW	28480 28480	1854-0540 1854-0540
A 1A 2R 1 A 1A 2R 2 A 1A 2R 3 A 1A 2R 4 A 1A 2R 5	0698-3440 0698-3429 2100-1984 0698-7256 0698-7248	4 1 2 3	RESISTOR 196 OHM 1% .125W F TUBULAR RESISTOR 19.6 OHM 1% .125W F TUBULAR RESISTOR; VAR; TRMR; 100 OHM 10% C RESISTOR 6.81K 2% .05W F TUBULAR RESISTOR 3.16K 2% .05W F TUBULAR	16299 03888 30983 24546 24546	C4-1/8-T0-196R-F PM555-1/8-T0-19R6-F ET50W101 C3-1/8-T0-6811-G C3-1/8-T0-3161-G
A 1 A 2R 6 A 1 A 2R 7 A 1 A 2R 8 A 1 A 2R 9	0698-7219 0698-7256 0698-7248 0698-7219		RESISTOR 196 OHM 2% +05W F TUBULAR RESISTOR 6+81K 2% +05W F TUBULAR RESISTOR 3+16K 2% +05W F TUBULAR RESISTOR 196 OHM 2% +05W F TUBULAR	24546 24546 24546 24546	C3-1/8-T0-196R-G C3-1/8-T0-6811-G C3-1/8-T0-3161-G C3-1/8-T0-196R-G
A1A3	11661-60014	1	4 GHZ LOW PASS FILTER ASSY	28480	11661-60014
A1A4	11661-60012	1	4.43 GHZ OSCILLATOR TUNING ASSY	28480	11661-60012
A1A4C1 A1A4C2 A1A4C3	0180-0197 0180-0197 0180-0197		CAPACITOR-FXD; 2.2UF+-10% 20VDC TA CAPACITOR-FXD; 2.2UF+-10% 20VDC TA CAPACITOR-FXD; 2.2UF+-10% 20VDC TA	56289 56289 56289	150D225X902042 150D225X9020A2 150D225X9020A2
A 1A 4R 1 A 1A 4R 2	0698-7195 0757-0405	1	RESISTOR 19.6 OHM 23 .05W F TUBULAR Resistor 162 OHM 13 .125W F TUBULAR	24546 24546	C3-1/8-T00-19R6-G C4-1/8-T0-162R-F
A1A4VR1	1901-1034	1	DIODE-STABISTOR 90V	03508	MPD400
A2	11661-60006	1	MOTHER BOARD ASSY	28480	11661-60006
A2C1 A2C2 A2C3	0 160 20 55 0 160 20 55 0 160 20 55	9	CAPACITOR-FXD .01UF +80-20% 100WVDC CER CAPACITOR-FXD .01UF +80-20% 100WVDC CER CAPACITOR-FXD .01UF +80-20% 100WVDC CER	28480 28480 28480	0160-2055 0160-2055 0160-2055
A 2J 1 A 2J 2 A 2J 3 A 2J 4 A 2J 5	1250–1377 1250–1377 1250–1377 1250–1377 1250–1377 1250–1377	5	CONNECTOR-RF SMB FEM PC Connector-RF SMB FEM PC Connector-RF SMB FEM PC Connector-RF SMB FEM PC Connector-RF SMB FEM PC	2K 497 2K 497 2K 497 2K 497 2K 497 2K 497	700214 700214 700214 700214 700214 700214
A 2X A3 A 2X A4 A 2X A5 A 2X A6 A 2X A7	1251-1626 1251-1626 1251-1626 1251-1626 1251-1626 1251-1626	5	CONNECTOR; PC EDGE; 12-CONT; DIP SOLDER CONNECTOR; PC EDGE; 12-CONT; DIP SOLDER	71785 71785 71785 71785 71785 71785	252-12-30-300 252-12-30-300 252-12-30-300 252-12-30-300 252-12-30-300 252-12-30-300
A3	11661-60004	1	SUM LOOP PHASE DETECTOR ASSY	28480	11661-60004
A3C1 A3C2 A3C3 A3C4 A3C5	0180-2208 0180-2208 0160-3879 0160-3879 0160-3879 0160-3879	2	CAPACITOR-FXD; 220UF+-10% 10VDC TA CAPACITOR-FXD; 220UF+-10% 10VDC TA CAPACITOR-FXD .01UF +-20% 100WVDC CER CAPACITOR-FXD .01UF +-20% 100WVDC CER CAPACITOR-FXD .01UF +-20% 100WVDC CER	56289 56289 28480 28480 28480 28480	150D227X9010S2 150D227X9010S2 0160-3879 0160-3879 0160-3879
A 3C 6 A 3C 7 A 3C 8 A 3C 9 A 3C 10	0160-3878 0160-3878 0160-3879 0160-3879 0160-3878 0160-3879		CAPACITOR-FXD 1000 PF +-20% 100WVDC CER CAPACITOR-FXD 1000 PF +-20% 100WVDC CER CAPACITOR-FXD .01UF +-20% 100WVDC CER CAPACITOR-FXD 1000 PF +-20% 100WVDC CER CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480 28480 28480 28480 28480 28480	0160-3878 0160-3878 0160-3879 0160-3878 0160-3878
A 3C 11 A 3C 12 A 3C 13 A 3C 13 A 3C 14 A 3C 15	0160-3878 0160-3873 0160-3873 0160-3873 0160-3873 0160-3875	3	CAPACITOR-FXD 1000PF +-20% 100WVDC CER CAPACITOR-FXD 4.7PF +-5PF 200WVDC CER CAPACITOR-FXD 4.7PF +-5PF 200WVDC CER CAPACITOR-FXD 4.7PF +-5PF 200WVDC CER CAPACITOR-FXD 22PF +-5% 200WVDC CER 0+	28480 28480 28480 28480 28480 28480	0160-3878 0160-3873 0160-3873 0160-3873 0160-3873
A 3C 16 A 3C 17 A 3C 18 A 3C 19 A 3C 20	0160-3875 0160-3875 0160-3875 0160-3875 0160-3548 0160-3094	2 8	CAPACITOR-FXD 22PF +-5% 200WVDC CER 0+ CAPACITOR-FXD 22PF +-5% 200WVDC CER 0+ CAPACITOR-FXD 22PF +-5% 200WVDC CER 0+ CAPACITOR-FXD 201UF +-1% 100WVDC MICA CAPACITOR-FXD .1UF +-10% 100WVDC CER	28480 28480 28480 28480 28480 28480	0160-3875 0160-3875 0160-3875 0160-3548 0160-3094
A 3C 21 A 3C 22 A 3C 23 A 3C 23 A 3C 24 A 3C 25	0160-3094 0160-3879 0160-3094 0160-2306 0160-3548	1	CAPACITOR-FXD .1UF +-10% 100WVDC CER CAPACITOR-FXD .01UF +-20% 100WVDC CER CAPACITOR-FXD .1UF +-10% 100WVDC CER CAPACITOR-FXD 27PF +-5% 300WVDC MICA CAPACITOR-FXD .01UF +-1% 100WVDC MICA	28480 28480 28480 28480 28480 28480	0160-3094 0160-3879 0160-3094 0160-2306 0160-3548
A 3L 1 A 3L 2*	9140-0179 9140-0105	1	COIL: FXD; MOLDED RF CHOKE: 22UH 10% COIL: FXD; MOLDED RF CHOKE: 8.2UH 10%	24226 24226	15/222 15/821
A 3L 3 A 3L 4	9 100- 2551 9 140- 02 38	1 2	*FACTORY SELECTED PART COIL; FXD; MOLDED RF CHOKE; 12UH 10% COIL; FXD; MOLDED RF CHOKE; 82UH 5%	06560 24226	155-120K 15/822

See introduction to this section for ordering information

Table 6-2	Replaceable	Parts
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Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
A 31 5	9140-0238		CDIL: FXD: MOLDED RF CHOKE: 820H 5%	24226	15/822
A 301 A 302 A 303 A 304 A 305	1853-0007 1853-0007 1854-0221 1855-0049 1853-0007	15 2 1	TRANSISTOR PNP 2N3251 SI CHIP TRANSISTOR PNP 2N3251 SI CHIP TRANSISTOR NPN DUAL 2003-HFE 10MV-VBE TRANSISTOR; JFET;DUAL; N-CHAN D-MODE SI TRANSISTOR PNP 2N3251 SI CHIP	04713 04713 28480 28480 04713	2N3251 2N3251 1054-0221 1855-0049 2N3251
A 3R 1 A 3P 2 A 3R 3 A 3R 4 A 3R 5	0698-7236 0698-7236 0698-7236 0698-7236 0698-7236 0698-7224	10	RESISTOR 1K 2% .05W F TUBULAR RESISTOR 316 OHM 2% .05W F TUBULAR	24546 24546 24546 24546 24546 24546	C3-1/8-T0-1001-G C3-1/8-T0-1001-G C3-1/8-T0-1001-G C3-1/8-T0-1001-G C3-1/8-T0-316R-G
A 3R 6 A 3R 7 A 3R 8 A 3R 9 A 3F 10	0698-7222 0698-7224 0698-7222 0698-7225 0698-7225	3	RESISTOR 261 OHM 23 .05W F TUBULAR RESISTOR 316 OHM 23 .05W F TUBULAR RESISTOR 261 OHM 23 .05W F TUBULAR RESISTOR 348 OHM 23 .05W F TUBULAR RESISTOR 348 OHM 23 .05W F TUBULAR	24546 24546 24546 24546 24546 24546	C3-1/8-T0-261R-G C3-1/8-T0-316R-G C3-1/8-T0-261R-G C3-1/8-T0-348R-G C3-1/8-T0-348R-G
A 3R 11 A 3R 12 A 3R 13 † A 3R 14 A 3F 15	0698-7218 0698-7224 0698-7253 0698-7224 0698-7224	2	RESISTOR 178 OHM 2% .05W F TUBULAR RESISTOR 316 OHM 2% .05W F TUBULAR RESISTOR 5.11 K 2% .05W F TUBULAR RESISTOR 316 OHM 2% .05W F TUBULAR RESISTOR 316 OHM 2% .05W F TUBULAR	24546 24546 24546 24546 24546 24546	C3-1/8-T0-178R-G C3-1/8-T0-316R-G C3-1/8-T0-5111-G C3-1/8-T0-316R-G C3-1/8-T0-316R-G
A 3R 16 † A 3R 17 † A 3R 18 A 3R 19 † A 3R 20	0698-7253 0698-7244 0698-7244 0698-7244 0698-7244 0698-7244	7	RESISTOR 5.11 K 23 .05W F TUBULAR RESISTOR 2.15K 23 .05W F TUBULAR	24546 24546 24546 24546 24546 24546	C3-1/8-T0-5111-G C3-1/8-T0-2151-G C3-1/8-T0-2151-G C3-1/8-T0-2151-G C3-1/8-T0-2151-G
A 3R 21 A 3R 22 A 3R 23 A 3R 23 A 3R 24 A 3R 25	0 69 8- 7253 0 69 8- 7244 0 69 8- 7244 0 69 8- 7244 0 69 8- 71 88 0 69 8- 7277	2 5 2	RESISTOR 5.11K 2% .05W F TUBULAR RESISTOR 2.15K 2% .05W F TUBULAR RESISTOR 2.15K 2% .05W F TUBULAR RESISTOR 10 0HM 2% .05W F TUBULAR RESISTOR 51.1K 2% .05W F TUBULAR	24546 24546 24546 24546 24546 24546	C3-1/8-T0-5111-G C3-1/8-T0-2151-G C3-1/8-T0-2151-G C3-1/8-T00-10R-G C3-1/8-T0-5112-G
A 3R 26 A 3R 27 A 3R 28 A 3R 29 A 3R 30	0698-7188 0698-7205 0698-7260 0698-7249 0698-7205	2	RESISTOR 10 OHM 2% .05W F TUBULAR RESISTOR 51.1 OHM 2% .05W F TUBULAR RESISTOR 10K 2% .05W F TUBULAR RESISTOR 3.48K 2% .05W F TUBULAR RESISTOR 51.1 OHM 2% .05W F TUBULAR	24546 24546 24546 24546 24546 24546	C3-1/8-T00-10R-G C3-1/8-T00-51R1-G C3-1/8-T0-1002-G C3-1/8-T0-3481-G C3-1/8-T00-51R1-G
A 3R 31 A 3R 32 A 3R 33 A 3R 34 A 3R 35	0698-7241 0698-7277 0698-7253 0698-7260 0698-3154	2	RESISTOR 1.62K 2% .05W F TUBULAR RESISTOR 51.1K 2% .05W F TUBULAR RESISTOR 5.11K 2% .05W F TUBULAR RESISTOR 10K 2% .05M F TUBULAR RESISTOR 4.22K 1% .125W F TUBULAR	16299 24546 24546 24546 24546 16299	C3-1/8-T0-1621-G C3-1/8-T0-5112-G C3-1/8-T0-5111-G C3-1/8-T0-1002-G C4-1/8-T0-4221-F
A 3U 1 A 3U 2 A 3U 3	1 82 0- 06 81 1 820- 06 85 1 820- 06 81	2 1	IC DGTL SN74S 00 N GATE IC DGTL SN74S 10 N GATE IC DGTL SN74S 00 N GATE	01295 01295 01295	SN74SOON SN74S10N SN74S00N
			A3 MISCELLANEOUS		
	0360-0124 1480-0073 4040-0748 4040-0753	2 10 5 1	TERMINAL, STUD .040 " PIN:DRIVE 0.250" LG Extractor, p.C. Board, Black Extractor-PC Board, Green	97300 00000 28480 28480	SIZE A OBD 4040-0748 4040-0753
۵4	11661-60005	1	SUM LOOP PRETUNE ASSY	28480	11661-60005
A4C1 A4C2 A4C3 A4C4 A4C5	0160-0127 0160-0127 0180-0183 0160-2254 0160-3879	6 1 1	CAPACITOR-FXD 1UF ←20% 25WVDC CER CAPACITOR-FXD 1UF ←20% 25WVDC CER CAPACITOR-FXD; 10UF+75-10% 50VDC AL CAPACITOR-FXD 7.5PF ←-25PF 500WVDC CER CAPACITOR-FXD .01UF ←20% 100WVDC CER	28480 28480 56289 28480 28480	0160-0127 0160-0127 30D106G050CB2 0160-2254 0160-3879
A4C6 A4C7 A4C8*	0 160- 30 94 0 160- 38 79 0 140-01 99	1	CAPACITOR-FXD .1UF +-103 100WVDC CER CAPACITOR-FXD .01UF +-203 100WVDC CER CAPACITOR-FXD 240PF +-53 300WVDC MICA *FACTORY SELECTED PART	28480 28480 72136	0160-3094 0160-3879 DM15F241J0300WV1CR
A4CR1	1901-0050	1	DIODE-SWITCHING 2NS 80V 200MA	28480	1901-0050
A 4L 1 A 4L 2	9140-0138 9100-2261	1 1	COIL; FXD; MOLDED RF CHOKE; 180UH 5% Coil; FXD; Molded RF Choke; 2.7UH 10%	24226 99800	15/183 1025-30
A401 A402 A403 A404 A405	1853-0007 1853-0007 1853-0007 1853-0007 1853-0007 1853-0007		TRANSISTOR PNP 2N3251 SI CHIP TRANSISTOR PNP 2N3251 SI CHIP TRANSISTOR PNP 2N3251 SI CHIP TRANSISTOR PNP 2N3251 SI CHIP TRANSISTOR PNP 2N3251 SI CHIP	04713 04713 04713 04713 04713 04713	2N3251 2N3251 2N3251 2N3251 2N3251 2N3251
A406 A407 A408 A409 A409	1853-0007 1853-0007 1853-0007 1853-0007 1853-0007		TRANSISTOR PNP 2N3251 SI CHIP TRANSISTOR PNP 2N3251 SI CHIP TRANSISTOR PNP 2N3251 SI CHIP TRANSISTOR PNP 2N3251 SI CHIP TRANSISTOR PNP 2N3251 SI CHIP	04713 04713 04713 04713 04713 04713	2N3251 2N3251 2N3251 2N3251 2N3251 2N3251

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Table 6-2. Replaceable Fun	Table	<i>6-2</i> .	Replaceable	Parts
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Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
A4011 A4012	1853-0007 1853-0007		TRANSISTOR PNP 2N3251 SI CHIP TRANSISTOR PNP 2N3251 SI CHIP	04713 04713	2N3251 2N3251
A4R 1 A4R 2 A4R 3 A4R 4 A4R 5	0698-7188 0757-0441 0698-7217 0698-7240 2100-1986	1 2 5	RESISTOR 10 OHM 2% .05W F TUBULAR RESISTOR 8.25K 1% .125W F TUBULAR RESISTOR 162 OHM 2% .05W F TUBULAR RESISTOR 1.47K 2% .05W F TUBULAR RESISTOR; VAR; TRMR; 1KOHM 10% C	24546 24546 24546 24546 30983	C3-1/8-T00-10R-G C4-1/8-T0-8251-F C3-1/8-T0-162R-G C3-1/8-T0-1471-G ET50W102
A4R 6 A4R 7 A4R 8 A4R 9 A4R 10	2100-1986 0698-3101 0698-7212 0698-7218 0698-7241	1	RESISTOR; VAR; TRMR; 1KOHM 10% C RESISTOR 2.87K 1% .5W F TUBULAR RESISTOR 100 OHM 2% .05W F TUBULAR RESISTOR 178 OHM 2% .05W F TUBULAR RESISTOR 1.62K 2% .05W F TUBULAR	30983 03888 24546 24546 16299	ET50W102 PME65-1/2-T0-2871-F C3-1/8-T0-100R-G C3-1/8-T0-18R-G C3-1/8-T0-1621-G
A4R 11 A4R 12 A4R 13 A4R 14 A4R 15	2100-2061 0698-7258 0698-7212 0698-7219 0698-7242	4 1 1	RESISTOR; VAR; TRMR; 200 OHM 10% C RESISTOR 8.25K 2% .05W F TUBULAR RESISTOR 100 OHM 2% .05W F TUBULAR RESISTOR 196 OHM 2% .05W F TUBULAR RESISTOR 1.78K 2% .05W F TUBULAR	30983 24546 24546 24546 24546 24546	ET50W201 C3-1/8-T0-8251-G C3-1/8-T0-100R-G C3-1/8-T0-196R-G C3-1/8-T0-1781-G
A4R 16 A4R 17 A4R 18 A4R 19 A4R 20	2100-2061 0698-7276 0698-7220 0698-7243 2100-2061	1 1	RESISTOR; VAR; TRMR; 200 OHM 10% C RESISTOR 46.4K 2% .05W F TUBULAR RESISTOR 215 OHM 2% .05W F TUBULAR RESISTOR 1.96K 2% .05W F TUBULAR RESISTOR; VAR; TRMR; 200 OHM 10% C	30983 24546 24546 24546 30983	ET50W201 C3-1/8-T0-4642-G C3-1/8-T0-215R-G C3-1/8-T0-1961-G ET50W201
A4R 21 A4R 22 A4R 23 A4R 24 A4R 25	0698-7221 0698-7244 2100-1788 0698-7222 0698-7245	1 2	RESISTOR 237 OHM 2 %.0 5W F TUBULAR RESISTOR 2.15K 2 %.0 5W F TUBULAR RESISTOR; VAR; TRMR; 500 OHM 10% C RESISTOR 261 OHM 2 %.0 5W F TUBULAR RESISTOR 2.37K 2 %.0 5W F TUBULAR	24546 24546 30983 24546 24546	C3-1/8-T0-237R-G C3-1/8-T0-2151-G ET50M501 C3-1/8-T0-261R-G C3-1/8-T0-2371-G
A 4R 26 A 4R 27 A 4R 28 A 4R 29 A 4R 30	2100-1788 0698-7223 0698-7246 2100-1986 0698-7224	2 1	RESISTOR; VAR; TRMR; 500 DHM 10% C RESISTOR 287 DHM 2% .05W F TUBULAR RESISTOR 2.61K 2% .05W F TUBULAR RESISTOR; VAR; TRMR; 1KOHM 10% C RESISTOR 316 OHM 2% .05W F TUBULAR	30983 24546 24546 30983 24546	ET50W501 C3-1/8-T0-287R-G C3-1/8-T0-2611-G ET50W102 C3-1/8-T0-316R-G
A4R 31 A4R 32 A4R 33 A4R 34 A4R 35	0698-7247 2100-1986 0698-7225 0698-7248 2100-1986		RESISTOR 2.87K 2% .05W F TUBULAR RESISTOR; VAR; TRMR; 1KDHM 10% C RESISTOR 348 OHM 2% .05W F TUBULAR RESISTOR 3.16K 2% .05W F TUBULAR RESISTOR; VAR; TRMR; 1KDHM 10% C	24546 30983 24546 24546 30983	C3-1/8-T0-2871-G ET50W102 C3-1/8-T0-348R-G C3-1/8-T0-3161-G ET50W102
A 4R 36 A 4R 37 A 4R 38	0698-7226 0698-7249 2100-2497	1	RESISTOR 383 OHM 2% .05W F TUBULAR Resistor 3.48K 2% .05W F Tubular Resistor; Var; Trmr; 2Kohm 10% C	24546 24546 19701	C3-1/8-T0-383R-G C3-1/8-T0-3481-G ET50W202
A4U1	1820-0214	1	IC DGTL SN74 42 N DECODER	01295	SN7442N
			A4 MISCELLANEOUS		
	1480-0073 4040-0748 4040-0752	1	PIN:DRIVE 0.250" LG Extractor, p.C. Board, black Extractor-PC Board, yellow	00000 28480 28480	080 4040-0748 4040-0752
A5	11661-60001	1	YIG LOOP PRETUNE ASSY	28430	11661-60001
A5C1 A5C2 A5C3 A5C4 A5C5	0180-2207 0180-2206 0160-2204 0160-3456 0160-3094	1 2 1 1	CAPACITOR-FXD; 100UF+-10% 10VDC TA CAPACITOR-FXD; 60UF+-10% 6VDC TA-SOLID CAPACITOR-FXD 100PF +-5% 300WVDC MICA CAPACITOR-FXD 1000PF +-10% 1000WVDC CER CAPACITOR-FXD .1UF +-10% 100WVDC CER	56289 56289 28480 28480 28480 28480	150D107X9010R2 150D606X900682 0160-2204 0160-3456 0160-3094
A5C6 A5C7 A5C8 †	0160-2055 0160-3094 0180-0291	8	CAPACITOR-FXD .01UF +80-20% 100WVDC CER CAPACITOR-FXD .1UF +-10% 100WVDC CER CAPACITOR-FXD; 1UF+-10% 35VDC TA-SOLID	28480 28480 56289	0160-2055 0160-3094 150D105X9035A2
A5CR1 A5CR2 †	1901-0376 1901-0376	2	DIDDE-GEN PRP 35V 50MA DIDDE-GEN PRP 35V 50MA	28480 28480	1901-0376 1901-0376
A501 A502 A503 A504 A505	1 854-0071 1 854-0071 1 854-0071 1 854-0071 1 854-0071 1 854-0071	5	TRANSISTOR NPN SI PD=300MW FT=200MHZ TRANSISTOR NPN SI PD=300MW FT=200MHZ TRANSISTOR NPN SI PD=300MW FT=200MHZ TRANSISTOR NPN SI PD=300MW FT=200MHZ TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480 28480 28480 28480 28480 28480	1854-0071 1854-0071 1854-0071 1854-0071 1854-0071
A 506 A 507 A 508 A 509	1854-0221 1855-0020 1854-0062 1854-0062	2 2	TRANSISTOR NPN DUAL 200%-HFE 10MV-VBE TRANSISTOR; J-FET N-CHAN, D-MODE SI TRANSISTOR NPN 2N1701 SI PD=25W TRANSISTOR NPN 2N1701 SI PD=25W	28480 28480 04713 04713	1854-0221 1855-0020 2N3055 2N3055
A5R 1 A5R 2 A5R 3 A5R 4 A5R 5	0757-0421 0698-7229 0698-7229 0698-7229 0698-7229 0698-7229	1 5	RESISTOR 825 OHM 1% .125W F TUBULAR RESISTOR 511 OHM 2% .05W F TUBULAR	24546 24546 24546 24546 24546 24546	C4-1/8-T0-825R-F C3-1/8-T0-511R-G C3-1/8-T0-511R-G C3-1/8-T0-511R-G C3-1/8-T0-511R-G C3-1/8-T0-511R-G

Table 6-2. Replaceable Parts

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
A5R6 A5F7 A5R8 A5R9 A5R10	0698-7229 0698-7272 0698-7272 0698-7272 0698-7272 0698-7272	5	RESISTOR 511 DHM 2% .05W F TUBULAR RESISTOR 31.6K 2% .05W F TUBULAR	24546 24546 24546 24546 24546	C3-1/8-T0-511R-G C3-1/8-T0-3162-G C3-1/8-T0-3162-G C3-1/8-T0-3162-G C3-1/8-T0-3162-G
A5R 11 A5R 12 A5R 13 A5R 14 A5R 15 +	0698-7272 0757-0280 2100-3109 0811-3158 2100-3154	2 1 2 2	RESISTOR 31.6K 2% .05W F TUBULAR RESISTOR 1K 1% .125W F TUBULAR RESISTOR-VAR TRMR ZKOHM 10% C SIDE ADJ RESISTOR 40K .25% .025W PWN TUBULAR RESISTOR-VAR TRMR 1KOHM 10% C SIDE ADJ	24546 24546 32997 14140 32997	C3-1/8-T0-3162-G C4-1/8-T0-1001-F 3006P-1-202 1409-1/40-4002-25 3006P-1-102
A5R16 A5P17 A5R18 A5R19 A5R20	0811-3159 2100-3154 0811-3160 2100-3123 0811-3161	2 2 2 2	RESISTOR 20K ,25% .025W PWW TUBULAR RESISTOR-VAR TRMR 1K OHM 10% C SIDE ADJ RESISTOR 10K .25% .025W PWW TUBULAR RESISTOR-VAR TRMR 500 OHM 10% C SIDE ADJ RESISTOR 5K .25% .025W PWW TUBULAR	14 140 32997 14 140 32997 14 140	1409-1/40-2002-C 3006P-1-102 1409-1/40-1002-C 3006P-1-501 1409-1/40-5001-C
A 5R 21 † A 5R 22 A 5R 23 A 5R 24 A 5R 25	2100-3123 0811-3162 0811-3158 0811-3159 0811-3159	2	RESISTOR-VAR TRMR 500 DHM 10% C SIDE ADJ RESISTOR 4K -25% -025% PWM TUBULAR RESISTOR 40K -25% -025% PWW TUBULAR RESISTOR 20K -25% -025% PWW TUBULAR RESISTOR 10K -25% -025% PWW TUBULAR	32997 14140 14140 14140 14140 14140	3006P-1- ⁵⁰¹ 1409-1/40-4001-C 1409-1/40-4002-25 1409-1/40-2002-C 1409-1/40-1002-C
A 5R 26 A 5P 27 A 5R 28 A 5R 29 A 5R 30	0811-3161 0811-3162 0811-3163 2100-3229 0811-3163	2 2	RESISTOR 5K .25% .025W PWW TUBULAR RESISTOR 4K .25% .025W PWW TUBULAR RESISTOR 1K .25% .025W PWW TUBULAR RESISTOR-VAR TRMR 200 OHM 10% C SIDE ADJ RESISTOR 1K .25% .025W PWW TUBULAR	14140 14140 14140 32997 14140	1409-1/40-5001-C 1409-1/40-4001-C 1409-1/40-1001-C 3006P-1-201 1409-1/40-1001-C
A 5R 31 A 5R 32 A 5R 33 A 5R 34 A 5R 35	0698-0024 0698-3457 0698-7284 0698-3457 0698-3457 0698-7284	1 2 4	RESISTOR 2.61K 1% .5W F TUBULAR RESISTOR 316K 1% .125W F TUBULAR RESISTOR 100K 2% .05W F TUBULAR RESISTOR 316K 1% .125W F TUBULAR RESISTOR 100K 2% .05W F TUBULAR	03888 19701 24546 19701 24546	PME65-1/2-TO-2611-F MF4C1/8-TO-3163-F C3-1/8-TO-1003-G MF4C1/8-TO-3163-F C3-1/8-TO-1003-G
A 5R 36 A 5R 37 A 5R 38 A 5R 39 A 5R 40	0698-7260 0698-7260 0698-7260 2100-3229 0811-3164	1	RESISTOR 10K 2% .05W F TUBULAR RESISTOR 10K 2% .05W F TUBULAR RESISTOR 10K 2% .05W F TUBULAR RESISTOR-VAR TRMR 200 0HM 10% C SIDE ADJ RESISTOR 2.1K .25% .025W PWW TUBULAR	24546 24546 24546 32997 14140	C3-1/8-T0-1002-G C3-1/8-T0-1002-G C3-1/8-T0-1002-G 3006P-1-201 1409-1/40-2101-C
A5R41 A5R42 A5R43 A5R43 A5R45 A5R45	0698-7188 0698-7243 0811-3256 0698-7188 0811-3256	2	RESISTOR 10 OHM 2% .05W F TUBULAR RESISTOR 1.96K 2% .05W F TUBULAR RESISTOR 100 OHM .25% 3W PW TUBULAR RESISTOR 10 OHM 2% .05W F TUBULAR RESISTOR 100 OHM .25% 3W PW TUBULAR	24546 24546 00213 24546 00213	C3-1/8-T00-10R-G C3-1/8-T0-1961-G 12005 C3-1/8-T00-10R-G 12005
A 5U 1 A 5U 2	1820-0174 1820-0223	1 2	IC DGTL SN74 O4 N INVERTER IC LIN LM301AH AMPLIFIER	01295 27014	SN7404N LM301AH
A 5VR1 A 5VR2 A 5VR3 A 5VR4	1902-1216 1902-0202 1902-1216 1902-0202	2 2	DIODE; ZENER; 9V VZ; .5W MAX PD DIODE; ZENER; 15V VZ; 1W MAX PD DIODE; ZENER; 9V VZ; .5W MAX PD DIODE; ZENER; 15V VZ; 1W MAX PD	12954 04713 12954 04713	1N938A SZ11213-1 9 1 1N938A SZ11213-191
	0360-0124 1480-0073 4040-0748 4040-0751	1	A5 MISCELLANEOUS TERMINAL, STUD .040 " PIN:DRIVE 0.250" LG EXTRACTOR, P.C. BOARD, BLACK EXTRACTOR-PC BD ORN LEXAN .062 BD THKNS	97300 00000 28480 28480	SIZE A OBD 4040-0748 4040-0751
A6	11661-60002	1	FM DRIVER ASSY	28480	11661-60002
A6C1 A6C2 A6C3 A6C4 A6C5	0160-3879 0180-0291 0160-3879 0180-0197 0180-2141	2	CAPACITOR-FXD \bullet 01UF +-20% 100WVDC CER CAPACITOR-FXD; 1UF +-10% 35VDC TA-SOLID CAPACITOR-FXD; 0.01UF +-20% 100WVDC CER CAPACITOR-FXD; 2.2UF+-10% 20VDC TA CAPACITOR-FXD; 3.3UF+-10% 50VDC TA	28480 56289 28480 56289 56289	0160-3879 1500105X9035A2 0160-3879 150D225X9020A2 150D335X905082
A 6C 6 A 6C 7 A 6C 8 A 6C 9 A 6C 10	0180-2141 0160-0153 0180-2206 0160-0166 0160-3536	1 1 1	CAPACITOR-FXD; 3.3UF+-10% 50VDC TA CAPACITOR-FXD 1000PF +-10% 200WVDC POLYE CAPACITOR-FXD; 60UF+-10% 6VDC TA-SOLID CAPACITOR-FXD .068UF +-10% 200WVDC POLYE CAPACITOR-FXD 620PF +-5% 100WVDC MICA	56289 56289 56289 56289 56289 28480	150D335X905082 292P10292 150D606X900682 292P68392 0160-3536
A6C11 A6C12 A6C13 A6C14 A6C15	0180-0197 0160-3451 0160-3879 0160-3879 0160-3879 0180-0291	1	CAPACITOR-FXD; 2.2UF+-10% 20VDC TA CAPACITOR-FXD .01UF +80-20% 100WVDC CER CAPACITOR-FXD .01UF +-20% 100WVDC CER CAPACITOR-FXD .01UF +-20% 100WVDC CER CAPACITOR-FXD; 1UF+-10% 35VDC TA-SOLID	56289 28480 28480 28480 56289	1500225x9020A2 0160-3451 0160-3879 0160-3879 1500105x9035A2
A6C 16 A6C 17 A6C 18 A6C 19 A6C 20	0160-3094 0160-0127 0160-0127 0160-0127 0160-0158	1	CAPACITOR-FXD .1UF +-10% 100WVDC CER CAPACITOR-FXD 1UF +-20% 25WVDC CER CAPACITOR-FXD 1UF +-20% 25WVDC CER CAPACITOR-FXD 1UF +-20% 25WVDC CER CAPACITOR-FXD 5600PF +-10% 200WVDC POLYE	28480 28480 28480 28480 56289	0160-3094 0160-0127 0160-0127 0160-0127 292P56292

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Table 6-2. Replaceable Parts

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
A6C 21	0160-0127		CAPACITOR-FXD 1UF +-20% 25WVDC CER	28480	0160-0127
A6CR1 A6CR2 A6CR3 A6CR4 A6CR5	1910-0022 1910-0022 1901-0040 1901-0040	2	DIODE-SWITCHING 3.5NS 5V 60MA DIODE-SWITCHING 3.5NS 5V 60MA DIODE-SWITCHING 2NS 30V 50MA DIODE-SWITCHING 2NS 30V 50MA	28480 28480 28480 28480 28480 28480	1910-0022 1910-0022 1901-0040 1901-0040 1901-0040
A6CR6 A6CR7 A6CR8 A6CR9 A6CR9	1901-0040 1901-0040 1901-0040 1901-0040		DIODE-SWITCHING 2NS 30V 50MA DIODE-SWITCHING 2NS 30V 50MA DIODE-SWITCHING 2NS 30V 50MA DIODE-SWITCHING 2NS 30V 50MA DIODE-SWITCHING 2NS 30V 50MA	28480 28480 28480 28480 28480	1901-0040 1901-0040 1901-0040 1901-0040 1901-0040
A6CR11 A6CR12	1991-0040 1991-0040		DIODE-SWITCHING 2NS 30V 50MA DIODE-SWITCHING 2NS 30V 50MA	28480 28480	1901-0040 1901-0040
A6L 1	9140-0144		COIL; FXD; MOLDED RF CHOKE; 4.7UH 10%	24226	10/471
A601 A602 A603 A604	1853-0034 1854-0053 1854-0039 1205-0011 1853-0209 1205-0011	1 1 3 1	TRANSISTOR PNP SI CHIP TO-18 PD=360MW TRANSISTOR NPN 2N2218 SI PD=800MW TRANSISTOR NPN 2N3053 SI PD=1W HEAT-DISSIPATOR SGL TO-5 PKG TRANSISTOR PNP SI CHIP TO-39 PD=1W HEAT-DISSIPATOR SGL TO-5 PKG	28480 04713 04713 28480 28480 28480 28480	1853-0034 2N2218 2N3053 1205-0011 1853-0209 1205-0011
A 6Q 5 A 6Q 6	1853-0020 1855-0020	1	TRANSISTOR PNP SI CHIP PD=300MW TRANSISTOR; J-FET N-CHAN, D-MODE SI	28480 28480	1853-0020 1855-0020
A 6 R 1 A 6 R 2 A 6 R 3 A 6 R 4 A 6 R 5	0698-7215 0698-7215 0698-7219 0698-3405 0698-7209	2 1 1	RESISTOR 133 DHM 2% .05W F TUBULAP RESISTOR 133 DHM 2% .05W F TUBULAR RESISTOR 196 DHM 2% .05W F TUBULAR RESISTOR 422 DHM 1% .5W F TUBULAR RESISTOR 75 DHM 2% .05W F TUBULAR	24546 24546 24546 19701 24546	C3-1/8-T0-133R-G C3-1/8-T0-133R-G C3-1/8-T0-196R-G MF7C1/2-T0-422R-F C3-1/8-T00-75R0-G
A6R 6 A6R 7 A6R 8 A6R 9 A6R 10	2 100- 2520 0698- 7211 0698- 7230 0698- 7224 0698- 7236	1 1 2	RESISTOR; VAR; TRMR; 50 OHM 20% C RESISTOR 90.9 OHM 2% .05% F TUBULAR RESISTOR 562 OHM 2% .05% F TUBULAR RESISTOR 316 OHM 2% .05% F TUBULAR RESISTOR 1K 2% .05% F TUBULAR	19701 24546 24546 24546 24546	ET50X500 C3-1/8-T00-90R9-G C3-1/8-T0-562R-G C3-1/8-T0-316R-G C3-1/8-T0-1001-G
A 6R 11 A 6R 12 A 6R 13 A 6R 14 A 6R 15	0698-7260 0698-7264 0698-7223 0698-7284 0698-7252	2	RESISTOR 10K 2% .05W F TUBULAR RESISTOR 14.7K 2% .05W F TUBULAR RESISTOR 287 OHM 2% .05W F TUBULAR RESISTOR 100K 2% .05W F TUBULAR RESISTOR 4.64K 2% .05W F TUBULAR	24546 24546 24546 24546 24546 24546	C3-1/8-T0-1002-G C3-1/8-T0-1472-G C3-1/8-T0-287R-G C3-1/8-T0-103-G C3-1/8-T0-4641-G
A6R 16 A6R 17 A6R 18 A6R 19 A6R 20	0698-7284 0698-7264 0698-7224 0698-7240 0698-7236		RESISTOR 100K 2% .05W F TUBULAR RESISTOR 14.7K 2% .05W F TUBULAR RESISTOR 316 OHM 2% .05W F TUBULAR RESISTOR 1.47K 2% .05W F TUBULAR RESISTOR 1K 2% .05W F TUBULAR	24546 24546 24546 24546 24546	C3-1/8-T0-1003-G C3-1/8-T0-1472-G C3-1/8-T0-316R-G C3-1/8-T0-1471-G C3-1/8-T0-1001-G
A 6R 21 A 6R 22 A 6R 23 A 6R 24 A 6R 25	0698-7230 0698-7236 0698-7212 0698-7219 0757-1094	1	RESISTOR 562 OHM 2% .05W F TUBULAR RESISTOR 1K 2% .05W F TUBULAR RESISTOR 100 OHM 2% .05W F TUBULAR RESISTOR 196 OHM 2% .05W F TUBULAR RESISTOR 1.47K 1% .125W F TUBULAR	24546 24546 24546 24546 24546	C3-1/8-T0-562R-G C3-1/8-T0-1001-G C3-1/8-T0-100R-G C3-1/8-T0-198R-G C4-1/8-T0-1471-F
A 6R 26 A 6R 27 A 6R 28 A 6R 29 A 6R 30	0698-7236 0698-7236 0698-7212 0698-7212 0698-7243 0698-7219		RESISTOR 1K.2%.05W F TUBULAR RESISTOR 1K 2%.05W F TUBULAR RESISTOR 100 DHM 2%.05W F TUBULAR RESISTOR 1.96K 2%.05W F TUBULAR RESISTOR 196 DHM 2%.05W F TUBULAR	24546 24546 24546 24546 24546	C3-1/8-T0-1001-G C3-1/8-T0-1001-G C3-1/8-T0-100R-G C3-1/8-T0-1961-G C3-1/8-T0-196R-G
A 6R 31 A 6R 32 A 6R 33 A 6R 34 A 6R 35	0698-7236 0757-0280 0683-0475 0683-0475 0683-0475 0683-0275	2 1	RESISTOR 1K 2% .05W F TUBULAR RESISTOR 1K 1% .125W F TUBULAR RESISTOR 4.7 DHM 5% .25W CC TUBULAR RESISTOR 4.7 DHM 5% .25W CC TUBULAR RESISTOR 2.7 DHM 5% .25W CC TUBULAR	24546 24546 01121 01121 01121	C3-1/8-T0-1001-G C4-1/8-T0-1001-F C847G5 C847G5 C827G5
A 6R 36 A 6R 37 A 6R 38 A 6R 39 A 6R 40	0698-3427 0757-0346 0698-3427 0698-3427 0757-0795	3 1 1	RESISTOR 13.3 OHM 13.125W F TUBULAR RESISTOR 10 OHM 13.125W F TUBULAR RESISTOR 13.3 OHM 13.125W F TUBULAR RESISTOR 13.3 OHM 13.125W F TUBULAR RESISTOR 75 OHM 13.5W F TUBULAR	03888 24546 03888 03888 19701	PME55-1/8-T0-13R3-F C4-1/8-T0-10R0-F PME55-1/8-T0-13R3-F PME55-1/8-T0-13R3-F MF-1/2-T0-75R0-F
A6U1 A6U2	1821-0001 1820-0054	1 1	IC LIN CA3046 TRANSISTOR ARRAY IC DGTL SN74 OO N GATE	02735 01295	CA3046 SN7400N
A6VR1 A6VR2	1902-3048 1902-3002	1	DIODE-ZNR 3.48V 5% DO-7 PD=.4W TC= DIODE-ZNR 2.37V 5% DO-7 PD=.4W TC=	04713 04713	SZ 10939-50 SZ 10939-2
	0360-1514 1480-0073 4040-0748 4040-0750	4	A6 MISCELLANEOUS TERMINAL; SLDR STUD PIN:DRIVE 0.250" LG Extractor, P.C. Board, Black Extractor-PC Board, RED	28480 00000 28480 28480	0360-1514 OBD 4040-0748 4040-0750

See introduction to this section for ordering information

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
Δ7	11661-60003	1	YIG LOOP PHASE DETECTOR ASSY	28480	11661-60003
A7C1 A7C2 A7C3 A7C4 A7C5	0180-0291 0121-0036 0160-2055 0160-3879 0180-0197	1	CAPACITOR-FXD; 1UF+-10% 35VOC TA-SOLID CAPACITOR; VAR; TRMR; CER; 5.5/18PF CAPACITOR-FXD .01UF +80-20% 100WVDC CER CAPACITOR-FXD .01UF +-20% 100WVDC CER CAPACITOR-FXD; 2.2UF+-10% 20VDC TA	56289 73899 28480 28480 56289	150D105X9035A2 DV11PR18A 0160-2055 0160-3879 150D225X9020A2
A 7C 6 A 7C 7 A 7C 8 A 7C 9 A 7C 10	0160-2055 0180-0291 0160-2055 0180-0291 0180-0291 0180-0291		CAPACITOR-FXD .01UF +80-20% 100WVDC CER CAPACITOR-FXD; 1UF ←10% 35VDC TA-SOLID CAPACITOR-FXD .01UF +80-20% 100WVDC CER CAPACITOR-FXD; 1UF ←10% 35VDC TA-SOLID CAPACITOR-FXD; 1UF ←10% 35VDC TA-SOLID	28480 56289 28480 56289 56289	0160-2055 1500105 x903 5A2 0160-2055 1500105 x903 5A2 1500105 x903 5A2
A 7C 11 A 7C 12 A 7C 13 A 7C 14 A 7C 15	0180-0291 0180-0374 0160-3094 0160-2055 0160-0161	1	CAPACITOR-FXD; 1UF+-10% 35VDC TA-SOLID CAPACITOR-FXD; 10UF+-10% 20VDC TA-SOLID CAPACITOR-FXD .1UF +-10% 100WVDC CER CAPACITOR-FXD .01UF +80-20% 100WVDC CER CAPACITOR-FXD .01UF +-10% 200WVDC POLYE	56289 56289 28480 28480 56289	1500105X9035A2 1500106X902082 0160-3094 0160-2055 292P10392
A7C 16 A7C 17 A7C 18 A7C 19 A7C 20	0160-2055 0160-0945 0160-0939 0140-0194 0160-0945	2 1 1	CAPACITOR-FXD .01UF +80-20% 100WVDC CER CAPACITOR-FXD 910PF +-5% 100WVDC MICA CAPACITOR-FXD 430PF +-5% 300WVDC MICA CAPACITOR-FXD 110PF +-5% 300WVDC MICA CAPACITOR-FXD 910PF +-5% 100WVDC MICA	28480 28480 28480 72136 28480	0160-2055 0160-0945 0160-0939 DM15F111J0300WV1CR 0160-0945
A7CR1	1901-0025	1	DIODE-GEN PRP 100V 200MA	28480	1901-0025
A7L1 A7L2	9140-0144 9140-0142	1	COIL: FXD; MOLDED RF CHOKE: 4.7UH 10% COIL: FXD: MOLDED RF CHOKE: 2.2UH 10%	24226 24226	10/471 10/221
A701 A702 A703 A704 A705	1854-0019 1854-0019 1854-0019 1854-0019 1853-0001 1205-0011	4	TRANSISTOP NPN SI TO-18 PD=360MW TRANSISTOR NPN SI TO-18 PD=360MW TRANSISTOR NPN SI TO-18 PD=360MW TRANSISTOR NPN SI TO-18 PD=360MW TRANSISTOR PNP SI CHIP TO-39 PD=600MW HEAT-DISSIPATOR SGL TO-5 PKG	28480 28480 28480 28480 28480 28480 28480	1854-0019 1854-0019 1854-0019 1854-0019 1853-0001 1205-0011
A 7R 1 A 7R 2 A 7R 3 A 7R 4 A 7R 5	0757-0416 0698-7212 0757-0401 0698-3444 0698-3440	2 4	RESISTOR 511 OHM 1% .125W F TUBULAR RESISTOR 100 OHM 1% .125W F TUBULAR RESISTOR 100 OHM 1% .125W F TUBULAR RESISTOR 316 OHM 1% .125W F TUBULAR RESISTOR 196 OHM 1% .125W F TUBULAR	24546 24546 24546 16299 16299	C4-1/8-T0-511R-F C3-1/8-T0-100R-G C4-1/8-T0-101-F C4-1/8-T0-316R-F C4-1/8-T0-196R-F
A 7R 6 A 7R 7 A 7R 8 A 7R 9 A 7R 10	0698-7227 0757-0416 0698-3388 0698-3440 0757-0401	1 1	RESISTOR 422 OHM 23 .05W F TUBULAR RESISTOR 511 OHM 13 .125W F TUBULAR RESISTOR 14.7 OHM 13 .5W F TUBULAR RESISTOR 196 OHM 13 .125W F TUBULAR RESISTOR 100 OHM 13 .125W F TUBULAR	24546 24546 07716 16299 24546	C3-1/8-T0-422R-G C4-1/8-T0-511R-F CEC1/2-T0-14R7-F C4-1/8-T0-196R-F C4-1/8-T0-101-F
A7R 11 A7R 12 A7R 13 A7R 14 A7R 15	0698-3440 0698-3447 0698-3444 0698-3444 0698-3444 0698-7232	1	RESISTOR 196 OHM 1% .125W F TUBULAR RESISTOR 422 OHM 1% .125W F TUBULAR RESISTOR 316 OHM 1% .125W F TUBULAR RESISTOR 316 OHM 1% .125W F TUBULAR RESISTOR 681 OHM 2% .05W F TUBULAR	16299 16299 16299 16299 16299 24546	C4-1/8-T0-196R-F C4-1/8-T0-422R-F C4-1/8-T0-316R-F C4-1/8-T0-316R-F C3-1/8-T0-681R-G
A 7R 16 A 7F 17 A 7R 18 A 7R 19 A 7R 20	0698-7225 2100-2574 0698-7219 0698-3444 2100-2061	1	RESISTOR 34B OHM 2% .05W F TUBULAR RESISTOR; VAR; TRMR; 500 OHM 10% C RESISTOR 196 OHM 2% .05W F TUBULAR RESISTOR 316 OHM 1% .125W F TUBULAR RESISTOR; VAR; TRMR; 200 OHM 10% C	24546 19701 24546 16299 30983	C3-1/8-T0-348R-G ET50X501 C3-1/8-T0-196R-G C4-1/8-T0-316R-F ET50W201
A7T1	08552-6024	1	TRANSFORMER, RF YELLOW	28480	08552-6024
A7U1 A7U2 A7U3 A7U4 A7U5	1820-0253 1820-0253 1820-0253 1820-0145 1820-0223	3 1	IC DGTL MC 1035P SCHMITT TRIGGER IC DGTL MC 1035P SCHMITT TRIGGER IC DGTL MC 1035P SCHMITT TRIGGER IC DGTL MC 1010P GATE IC LIN LM301AH AMPLIFIER	04713 04713 04713 04713 27014	MC1035P MC1035P MC1035P MC1010P LM301AH
A7U6	10534C	1		28480	10534C
A7VR1 A7VR2 A7VR3	1902-0025 1902-0041 1902-3059	1 1 1	DIODE-ZNR 10V 5% DO-7 PD=.4W TC=+.06% DIODE-ZNR 5.11V 5% DO-7 PD=.4W TC= DIODE-ZNR 3.83V 5% DO-7 PD=.4W TC=	04713 04713 04713	SZ 10939-182 SZ 10939-98 SZ 10939-62
	0360-1514 1480-0073 4040-0748 4040-0749	1	AT MISCELLANEOUS TERMINAL; SLDR STUD PIN:DRIVE 0.250° LG Extractor, P.C. Board, Black Extractor-PC Board, Brown	28480 00000 28480 28480	0360-1514 080 4040-0748 4040-0749
8 8	11661-60038	1	50 MHZ FILTER ASSY (NON-REPAIRABLE)	28480	11661-60038
A 9	11661-60037	1	20 MHZ FILTER ASSY (NON-REPAIRABLE)	28480	11661-60037

See introduction to this section for ordering information

Table 6-2.	Replaceable	Parts
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Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
	5086-7023	1		28480	5086-7023
A10J1	5000 1025		NSR, MATES WITH A13P1	20100	
A11	11661-60036		2.6-4.1 GHZ BAND PASS FILTER ASSY	28480	11661-60036 058531-3
A 11MF 1	1250-1245		NSR. YIG DUTPHT CARLE. BLACK (INCL ATTME)	10117	0.04751-5
A11W2 A11W3			NSR, YIG LOOP OUTPUT CABLE, BLACKINGL JZ NSP, YIG LOOP FEEDBACK CABLE, GRAY/GREEN (INCLUDES MP2)		
A12	11661-60035	1	4.43 GHZ BAND PASS FILTER ASSY	28480	11661-60035
A12W1 A12W2			NSR,4.43GHZ BPF INPT,GRAY/RED(INCL MP2) NSR,4.43GHZ BPF OUPT,GRAY/ORG,(INCL MP2)		
A13	11661-60049	1	YIG WIRING HAPNESS ASSY	28480	11661-60049
A 13MP1	1 251-2570	7	CONTACT, CONN, U/W MICRO SER, MALE	71468	031-9540-000
A13P1	1251-2581	1	HOUSING STRIP:9 MALE CONTACT	71468	CTA4-1P-9
			CHASSIS PARTS		
J1 J2	1 250- 1221 1250- 1221	2	SUM LOOP DUTPUT JACK (P/O W1O) YIG LOOP DUTPUT JACK (P/O A11W2)	24931 24931	33JS118-1 33JS118-1
MP1	1251-0546	1	CONTACT:R & P CONNECTOR, RECTANGULAR (P/D W1, W3, W6, &W8 1 EACH)	81312	III 17054S
MP2	1250-1193	1	CONNECTOR-RF SM SLD FEM (P/O A11W3, A12W1, A12W2, AND W1, W3, W6, W7, W8, W9, W10, W12, W13; 1 EACH & P/O W2, W4, W5; 2 EACH)	98 29 1	52-328-0019
MP3	1250-0885	1	CONNECTOR, RF SMB FEM (P/O W7)	2K 497	700405
P4	11661-60018	1	CONNECTOR ASSY(INCL W1, W3, W6 & W8) Connector Body	28480 28480	11661-60018 5040-0380
	5040-0381 1251-3087	1 1	CONNECTOR FACE Contact, conn, u/w rectangular ser, fem	28480 81312	5040-0381 100-09085
R1	2100-2646	1	RESISTOR-VAR TRMR 100 OHM 10% C SIDE ADJ	32997	3059Y-1-101
w1†	11661-60020	2	CABLE ASSY, 20 MHZ FM/CW REFFRENCE INPUT WHITE/RED (P/O P4, INCLUDES MP1 & MP2)	28480	11661-60020
W2	11661-60021	1	CABLE ASSY,20 MHZ FILTER OUTPUT, RED (INCLUDES MP2)	28480	11661-60021
W3 🕇	11661-60029	1	CABLE ASSY, 100 MHZ REFERENCE INPUT, WHITE/BROWN(P/O P4, INCLUDES MP1 & MP2)	28 4 80	11661-60029
W4	11661-60031	1	CABLE ASSY, 20 MHZ FILTER INPUT, WHITE (INCLUDES MP2)	28480	11661-60031
W5 W6 †	11661-60032 11661-60030	1	CABLE ASSY, 50 MHZ FILTER IMPUTIINCL MP2 CABLE ASSY, 360 TO 450 MHZ INPUT, WHITE/ YELLOW (P/O P4; INCLUDES MP1 & MP2)	28480 28480	11661-60032 11661-60030
W7	11661-60022	1	CABLE ASSY,50 MHZ FILTER OUTPUT, YELLOW (Includes MP2 and MP3)	28480	11661-60022
w8 †	11661-60023	1	CABLE ASSY, 20 TO 30 MHZ INPUT, WHITE/ ORANGE (P/O P4; INCLUDES MP1 & MP2)	28480	11661-60023
W9	11661-60024	1	CABLE ASSY, VCO CONTROL SIGNAL, BLUE (INCLUDES MP2)	28480	11661-60024
₩10	11661-60050		CABLE ASSY, SUM LOOP OUTPUT, GRAY (Includes MP2 and J1)	28480	11661-60050
W11*	11661-60053	1	CABLE ASSY, ATTENUATOR, GRAY *FACTORY SELECTED PART	28480	11661-60053
W12	11661-60028	1	CABLE ASSY, SUM LOOP INTERCONNECT, GRAY (INCLUDES MP2)	28480	11661-60028
W12	1250-1375	1	CONNECTOR	28480	1250-1375
W13	11661-60026	1	CABLE ASSY, YIG LOOP INTERCONNECT, GRAY/BLUE (INCLUDES NP2)	28480	11661-60026
W13	1250-1373	1	CUNNECTOR CHASSIS MISCELLANEOUS	28480	1200-1373
	2360-0055	3	SCREW-MACH 6-32 BDG HD SLT REC NYL-NAT	95987	N-632-3/16
	6960-0016 11661-00001	11 1	PLUG; HOLE; TRUSS HD; .125 DIA NYLON FRAME	28480 28480	6960-0016 11661-00001
	11661-00002 11661-00003	1	BRACKET, CONNECTOR Clamp, yig Oscillator	28480 28480	11661-00002 11661-00003
	11661-00005 11661-20022	1 1	PANEL, TOP Guide, pc board	28480 28480	11661-00005 11661-20022

Mfr Code	Manufacturer Name	Address	Zip Code
CC000 00213 00865 03121 01295 03508 03508 04713 06560 07716 12954 14140 16299 19701 2×497 24226 24931 27014 28480 30983 3299 71468 71785 72136 73899 716554 73899 716554 79963 81312 95987 97800	U.S.A.COMMON SIGT REFORMULT THE ALLEN REALEY CO TRAKS INSTEINCS SPECIOND CMPAT DIV PCA CORP SHILD STATE DIV CCA CORP SHILD STATE DIV UC COSTICUTION DRUD RPT WHITPOLA SEMICONDUCTOR PRODUCTS ALLEN REALEY TRONGS CORP ON SPEC RELK DIV ALP RCCA CO THE INC EVELINGTIN DIV UC CONTROL SETTINGTON OF THE WHITPOLA SEMICONDUCTOR CORP ON SPECTAL INCOMPLETE CO CHANGE REFTRONCES CORP COMPANY SYSTEM INCOMPLETE CO THE LECK COMPONENTS INCOMP WHITPOLA SEMICONDUCTOR CORP MATIONAL SEMICONDUCTOR CORP MATIONAL SEMICONDUCTOR CORP MEDICITY CONNECTED CO DIACAMERE ELECTRIC CO DIACAMERE SYSTEM INCO CHANGE ELECTRIC CO DIACAMERE FLORE COMPONENT HO WHITPOLE COMPONENTS INTO DIV SPECTAL ELECTRIC CO DIACAMERE ELECTRIC CO DIACAMERE ELECTRIC CO DIACAMERE ELECTRIC CO DIACAMERE TRONG ONLY ELECTOR MOTIVE WEG CO TINC ELECTOR MOTIVE WEG CO TINC ELECTOR MOTIVE WEG CO TINC WICKESSEF CO TINC MICH ELECTRIC CO DIACAMERE PROMINE DELEVAN DIV WICKESSEF COL DIACAMERE SECORD DIACAMERE ELECTRIC CO DIACAMERE PROMINE DELEVAN DIV	ANY SUPPLIER OF USA ROCHESTEP NY CAZENOVIA NY MILWAUKEE WI DALLAS TX SOMMERVILLE NJ SYRACUSE NY WHIPPANY NJ PHOEMIX AZ NOGALES AZ RUPLINGTON IA SCOTTSDALE AZ MANCHESTER NH FARMINGTON MI PALEIGH NC MINEPAL WELLS TX NOPTH HAVEN CT GOWADDA NY RADEODED PA INDIANAPOLIS IN SANTA CLARA CA PALD ALTO CA SAN DIEGO CA PIVEPSIDE CA NORTH ADAMS MA SANTA ANA CA ELK GROVE VILLAGE IL WILLIMANTIC CT RROOKLYN NY CRYSTAL LAKE IL MT KISCO NY DAKVILLE CT CHICAGO IL CEDAP KNOLLS NJ MAMAPONECK NY AUPOPA NY	14610 13035 53212 75231 08876 13201 07981 85008 85621 52601 85252 03130 48024 27604 76067 06473 14070 15701 46227 95051 94304 92121 92507 01247 92702 60007 06226 11219 60014 10549 06779 60641 07927 10554 14052

Table 6-3. Code List of Manufacturers

SECTION VII MANUAL CHANGES

7-1. INTRODUCTION

7-2. This section contains manual change instructions for backdating this manual for HP Model 11661A Frequency Extension Modules that have serial number prefixes that are lower than the prefix listed on the title page. This section also contains instrument modification suggestions and procedures that are recommended to improve the performance and reliability of your generator.

7-3. MANUAL CHANGES

7-4. To adapt this manual to your instrument, refer to Table 7-1 and make all of the manual

changes listed opposite your instrument's serial number or prefix. The manual changes are listed in serial number sequence and should be made in the sequence listed. For example, Change A should be made after Change B; Change B should be made after Change C; etc. Table 7-2 is a summary of changes by component.

7-5. If your instrument's serial number or prefix is not listed on the title page of this manual or in Table 7-1, it may be documented in a yellow MANUAL CHANGES supplement. For additional important information about serial number coverage, refer to INSTRUMENTS COVERED BY MANUAL in Section I.

Serial Prefix or Number 1216A00100 to 00171	Make Manual Changes I, H, G, F, E, D, C, B, A	Serial Prefix or Number	Make Manual Changes —
1216A00171 to 00190	I, H, G, F, E, D, C, B	1409A	I, H, G
1216A00191 to 00205	I, H, G, F, E, D, C	1412A	I, H
1244A	I, H, G, F, E, D	1430A	I
1248A	I, H, G, F, E		
1250A	I, H, G, F		

Table 7-1. Manual Changes By Serial Number

-7	
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Change	A1	A2	A3	A4	A5	A6	A7	A8	A9	A10	A11	A12	No Prefix
А									R2 R3 R5 R7				
В	A2Q1												
С	A1L3							C1					
D					R15 R16 R43 R45								
					1								W1, W3, W6, W8
F					C8 CR2 VR4								
G	A2R10												
н					CR2 VR4								
I			R13 R16 R17 R19 R21										

*Instrument modification recommended, see paragraph 7-7.

Manual Changes

MANUAL CHANGES

7-6. MANUAL CHANGE INSTRUCTIONS

CHANGE A

Table 6-3:

Change A9R2 and A9R3 to 0698-7231 RESISTOR FXD 619 OHM 2% 1/8W 28480 0698-7231. Change A9R5 to 0698-7202 RESISTOR FXD 38.3 OHM 2% 1/8W 28480 0698-7202. Change A9R7 to 0698-7220 RESISTOR FXD 215 OHM 2% 1/8W 28480 0698-7220.

Service Sheet 4, A9 Assembly Schematic: Change R2 and R3 value to 619 ohms. Change R5 value to 38.3 ohms. Change R7 value to 215 ohms.

CHANGE B

Table 6-3:

Change A1A2Q1 and A1A2Q2 to 1854-0345 TRANSISTOR SILICON NPN 80131 2N5179.

Service Sheet 3, A1A2 Assembly Schematic: Change Q1 and Q2 part numbers to 1854-0345.

CHANGE C

Table 6-3:

Delete A1A1L3, A1A2C8, and A1A2R10. Change A8C1 to 0160-3877 CAPACITOR FXD CER 100 PF 80031 CV2059X7R101M.

Service Sheet 3:

Delete C8, L3, and R10 (complete circuit where C8 and L3 were removed). Change C2 on A8A1 assembly to C1. Change C3 on A8A1 assembly to C2.

Delete C1, 22pf in A8A1 assembly between U1/L1 junction and ground.

CHANGE D

Table 6-3:

Change A5R43 to 0811-3171 RESISTOR BXD 50 OHM 1/4% 3W 28480 0811-3171.

Delete A5R45.

Change A7R15 and R16 to 0757-0416 RESISTOR FXD MET FLM 511 OHM 1% 1/8W 28480 0757-0416.

Change A9C4 and A9C5 to 0160-2208 CAPACITOR FXD MICA 330 PF 5% 300 VDCW 28480 0160-2208.

Change A9C7 to 0140-0205 CAPACITOR FXD MICA 62 PF 5% 300 VDCW 00853 RDM15E620J3C.

Change A9C8 to 0160-2206 CAPACITOR FXD MICA 160 PF 5% 28480 0160-2206.

Service Sheet 2:

Change value of A5R43 to 50 ohms. Delete A5R45, 100 ohms.

Service Sheet 4:

Change value of A7R15 and A7R16 to 511 ohms

MANUAL CHANGES

CHANGE E

Table 6-3: Change W1, 3, 6 & 8 1251-0546 to 1251-2040 CONTACT: 81312 111-17054S.

CHANGE F

Table 6-3: Delete A5C8. Add A5CR2 1901-0376 DIODE:SILICON 35V 28480 1901-0376. Add A5VR4 1902-0202 DIODE:BREAKDOWN 15.0V 5% 1W 28480 1902-0202.

Service Sheet 2:

Delete A5C8.

Add A5CR2 and A5VR4 as shown (daggers indicate these parts have been changed, in this case deleted normally).

CHANGE G

Table 6-3: Add A1A2R10 0689-7209 RESISTOR:FXD FLM 75 OHM 2% 1/8W 28480 0698-7209.

Service Sheet 3:

Add R10, 75 to A1A2 assembly between L3/C8 junction and ground.

CHANGE H

Table 6-3: Delete A5CR2 and A5VR4.

Service Sheet 2: Delete A5CR2 and A5VR4.

CHANGE I

Table 6-3:

Change A3R13 and A3R16 to 0698-7224 RESISTOR: FXD 316 OHM 2% 1/8W 28480 0698-7224. Change A5R17 to 2100-3123, RESISTOR - VAR TRMR 500 OHM 10% SIDE ADJ, 32997, 3006P-1-501.

Change A5R19 and A5R21 to 2100-3095, RESISTOR – VAR TRMR 200 OHM 10% SIDE ADJ, 32997, 3006P-1-201.

Service Sheet 6:

Change value of A3R13 and 16 to 316 ohms.

7-7. INSTRUMENT IMPROVEMENT MODIFICATIONS

7-8. Hewlett-Packard has developed certain recommended instrument modifications that can be used to improve the performance and reliability of earlier versions of the instrument. In some cases, replacing certain parts requires a modification to make these instruments compatible with parts now in use (if the original part is no longer available). These modifications are outlined in the following procedures and are keyed to instruments by serial number or serial number prefix.

7-9. A7 YIG Loop Phase Detector Assembly Improvement (Serial Numbers 1216A00250 and Below)

7-10. On instruments with serial numbers 1216A00250 and below the Search Threshold Range may be increased by changing the resistor network for A7R17. Perform this modification if the A7R17 adjustment does not have sufficient range. The following parts are required:

Qty	Description	HP Part Number			
1	348 Ohm Resistor	0698-7225			
1	681 Ohm Resistor	0698-7232			

7-11. Remove the 11661A from the mainframe (refer to the last foldout of this manual for procedure) and continue as follows:

1. Unplug the 11661A, A7 circuit board. Refer to Figure 8-8 on Service Sheet 4, locate and replace A7R15 with the new 681 ohm resistor (0698-7232).

2. Locate and replace A7R16 with the new 348 ohm resistor (0698-7225). This completes the modification.

3. Perform the YIG Loop Phase Detector Adjustments given in paragraph 5-32 of this manual.

7-12. Winchester Connector Improvement (Serial Prefixes 1248A and Below)

7-13. On instruments with serial prefixes 1248A and below the 44 pin Winchester RF socket connectors may be strengthened with new retainer clips. These retainer clips, HP part number 1251-3044, significantly reduce the possibility of pushing out the RF sockets when the Extension Module is being installed. The RF socket hole in the Winchester connector must be drilled with a #34 drill so that the new, larger retainer clip will fit properly. If ordering a replacement cable for instruments with serial prefix 1248A and below, the Winchester connector RF socket hole must be drilled out.

7-14. If an RF socket is pushed out of the connector, perform the following modification. The following parts are required:

Qty	Description	HP Part No.		
3 (2 spares)	Retainer Clip	1251-3044		

Proceed as follows:

1. Push the defective RF socket out of the Winchester connector. Use pin removal tool, HP part number 8830-0025. Replace the socket retainer clip with a new retainer clip, HP part number 1251-3044 as shown in Figure 7-1.

2. In the Winchester connector, drill out the socket hole with a #34 drill. Be careful not to make the hole too large. Reinstall the RF socket into the connector. Use pin insertion tool, HP part number 8830-0025.



Figure 7-1. Connector Modification

7-15. YIG Pretune Driver Improvement (Serial Prefixes 1412A and Below)

7-16. On instruments with serial prefixes 1412A and below, improve protection to A5Q7 from

transients on the +20V power supply can be achieved by making one minor circuit modification. This change consists of adding a 1 μ F capacitor to the +20V supply line and replacing two diodes that may have been removed in a previous modification.

7-17. To modify the instrument the following parts are required:

Qty	Description	HP Part No.
1	A5C8, 1 μ F 35 V capacitor	0180-0291
1	A5VR4 Diode Breakdown 15.0V 5% 1W	1902-0202
1	A5CR2 Diode Silicon 30 MA 30 WV	1901-0040

7-18. To install the parts proceed as follows:

1. Remove A5 from the 11661A Frequency Module.

2. Form the leads of the 1 μ F capacitor, C8, to fit through the plated-through holes at edge connector pins 9 and 12 (see Figure 7-2). The capacitor leads should be long enough to keep the capacitor body completely clear of the edge connector.

3. Install the capacitor with the positive end connected to pin 9. Solder it very carefully to avoid bleeding solder onto the edge connector pins.

4. If diodes A5CR2 and A5VR4 have been removed due to a previous modification, reinstall them in their original locations by removing the $1 \mu F$ capacitor that was installed where A5VR4 was located

5. Remove the jumper wire that would have been added in the previous modification.

6. This completes the modification. No recalibration is necessary. Update your 11661A Operating and Service Manual parts list and A5 Schematic Diagram.

7-19. Improved SUM Loop Locking (Serial Prefixes 1431A and Below)

7-20. On instruments with serial prefixes 1431A and below the performance of the Sum Loop phase detector may be improved by changing the value of inductor A3L2. The propagation delay of integrated circuits A3U3 and A3U1 may vary slightly and allow the loop to become unlocked when the center frequency is stepped *up* from 99.9 MHz, 199.9 MHz, 299.9 MHz, etc., to 109.9 MHz, 209.9 MHz, 309.9 MHz, etc. Loop operation when stepping *down* in frequency will be normal.



Figure 7-2. Capacitor Installation

7-6

NOTE

Important - do not make this change if loop operation is normal when stepping up.

7-21. The value of A3L2 is changed from the 5.6 μ H to a 8.2 μ H nominal (HP part number 9140-0105) but the exact value must be determined by trial and error to obtain proper loop operation. The following parts are required:

Inductance	HP Part Number
5.6 µH ± 10%	9100-1618
$6.8\mu{ m H}\pm10\%$	9100-1619
$8.2 \mu { m H} \pm 10\%$	9140-0105
$10.0 \mu \mathrm{H} \pm 10\%$	9140-0114
$12.0 \ \mu H \pm \ 10\%$	9140-0178

NOTE

In instruments with serial prefixes below 1412A this inductor was $12 \ \mu$ H.

7-22. Remove the mainframe top cover and the cover of the 11661A Frequency Extension Module (refer to the last foldout of this manual for procedure) and proceed as follows:

1. Unplug the A3 (green extractor) circuit board.

2. Locate A3L2 (see Service Sheet 6) and replace with one of the new value.

3. Reintall the circuit board and observe the RF output signal on a spectrum analyzer while stepping from 99.9 MHz to 109.9 MHz, etc., to determine if the loop is reliably locking. If the loop is not locking properly, select values from the table below until proper operation is achieved.

4. After reliable locking is achieved when stepping, cycle the instrument off and then on to assure the loop locks at the turn-on.

- MANUAL IDENTIFICATION -

Model Number:11661ADate Printed:August, 1972Part Number:11661-90003

This supplement contains important information for correcting manual errors and for adapting the manual to instruments containing improvements made after the printing of the manual.

To use this supplement:

Make all ERRATA corrections

Make all appropriate serial number related changes indicated in the tables below.

Serial Prefix or Number	Make Manual Changes	Serial Prefix or Number	Make Manual Changes
1216A00171 to 00190	1	1248A	1, 2, 3, 4
1216A00191 to 00205	1,2	► 1250A	1, 2, 3, 4, 5
1244A	1,2,3		

► NEW ITEM

CHANGE 1

Page 4-11, Table 4-3:

Change A9A1R2 to 0698-7226 R:FXD FLM 383 OHM 2% 1/8W 28480 0698-7226. Change A9A1R3 to 0698-7233 R:FXD FLM 750 OHM 2% 1/8W 28480 0698-7233. Change A9A1R5 to 0698-7196 R:FXD FLM 21.5 OHM 2% 1/8W 28480 0698-7196. Change A9A1R7 to 0698-7228 R:FXD FLM 464 OHM 2% 1/8W 28480 0698-7228.

Service Sheet 3, A9A1 Assembly Schematic: Change R2 value to 383. Change R3 value to 750. Change R5 value to 21.5. Change R7 value to 464.

CHANGE 2

Page 4-5, Table 4-3: Change A1A2Q1 to 1854-0540 TSTR: SI NPN 04713 MM 8006. Change A1A2Q2 to 1854-0540 TSTR: SI NPN 04713 MM 8006.

Service Sheet 2, A2A2 Assembly Schematic: Change Q1 part number to 1854-0540. Change Q2 part number to 1854-0540.

NOTE

Manual change supplements are revised as often as necessary to keep manuals as current and accurate as possible. Hewlett-Packard recommends that you periodically request the latest edition of this supplement. Free copies are available from all HP offices. When requesting copies quote the manual identification information from your supplement, or the model number and print date from the title page of the manual.



9 January 1973

2

CHANGE 3

Page 4-5, Table 4-3:

Add A1A1L3 9140-0144 COIL: FXD RF 4.7 UH 28480 9140-0144.

- Add A1A2C8 0160-2257 C:FXD CER 10 PF 5% 500 VDCW 72982 301-000-COHO-100J.
- Add A1A2R10 0698-7209 R:FXD FLM 75 OHM 2% 1/8W 28480 0698-7209.

Page 4-11, Table 4-3:

Change A8A1C1 to A8A1C2 0160-3877 C:FXD CER 100 PF 20% 200 VDCW 80031 CV2059X7R101M. Change A8A1C2 to A8A1C3 0160-3877 C:FXD CER 100 PF 20% 200 VDCW 80031 CV2059X7R101M. Add A8A1C1 0160-3875 C:FXD CER 22 PF 5% 200 VDCW 72982 8121-8227-COG-200J.

Service Sheet 2:

Add L3, 4.7 to A1A1 assembly in series with $-10V_1$ input line.

Add C8, 10 to A1A2 assembly between L3 and A1 $\overline{J8}$ on 380-480 MHz output line.

Add R10, 75 to A1A2 assembly between L3/C8 junction and ground.

Change C1 on A8A1 assembly to C2.

Change C2 on A8A1 assembly to C3.

Add C1, 22 pF to A8A1 assembly between U1/L1 junction and ground.

CHANGE 4

Page 4-9, Table 4-3:

Change A5R43 to 0811-3256 R:FXD WW 100 OHM 0.25% 3W 28480 0811-3256. Add A5R45 0811-3256 R:FXD WW 100 OHM 0.25% 3W 28480 0811-3256.

Page 4-11, Table 4-3:

Change A7R15 to 0698-7232 R:FXD FLM 681 OHM 2% 1/8W 28480 0698-7232. Change A7R15 to 0698-7225 R:FXD FLM 348 OHM 2% 1/8W 28480 0698-7225. Change A9A1C4 to 0160-2012 C:FXD MICA 330 PF 5% 500 VDCW 28480 0160-2012. Change A9A1C5 to 0160-2012 C:FXD MICA 330 PF 5% 500 VDCW 28480 0160-2012. Change A9A1C6 to 0160-2029 C:FXD MICA 36 PF 5% 500 VDCW 28480 0160-2029. Change A9A1C7 to 0160-2016 C:FXD MICA 62 PF 5% 500 VDCW 14655 RDM15E620J5S. Change A9A1C8 to 0160-2529 C:FXD MICA 160 PF 5% 500 VDCW 28480 0160-2529.

Service Sheet 1:

Change **R43** value to 100. Add R45, 100 in parallel with R43.

Service Sheet 3, A7 Assembly Schematic: Change R15 value to 681. Change R16 value to 348.

CHANGE 5

Page 4-12, Table 4-3:

Change W1 1251-2040 to 1251-0546 CONTACT: R-P CONNECTOR (PIN A of P1) 81312 111-17054S. Change W3 1251-2040 to 1251-0546 CONTACT: R-P CONNECTOR (PIN D of P1) 81312 111-17054S. Change W6 1251-2040 to 1251-0546 CONTACT: R-P CONNECTOR (PIN C of P1) 81312 111-17054S. Change W8 1251-2040 to 1251-0546 CONTACT: R-P CONNECTOR (PIN B of P1) 81312 111-17054S.

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SECTION VIII SERVICE

8-1. INTRODUCTION

8-2. This section contains troubleshooting and repair information for the HP Model 11661A Frequency Extension Module. Safety considerations, principles of operation, and recommended test equipment are included.

8-3. The service sheets normally include principles of operation and troubleshooting information, a component location diagram, and a schematic, all relating to a specific portion of circuitry within the instrument.

8-4. Service Sheet 1 includes an overview of the instrument operation, troubleshooting to an assembly or stage level, and a troubleshooting block diagram. The block diagram also serves as an "index" for the other service sheets.

8-5. The last foldout in this section gives disassembly procedures, adjustment locations, test point locations, and a table which cross-references pictorial and schematic locations of each assembly and chassis mounted component.

8-6. SAFETY CONSIDERATIONS

8-7. Although this instrument has been designed in accordance with international safety standards, this manual contains information, catuions, and warnings which must be followed to ensure safe operation and to retain the instrument in safe condition (see Sections II, III, and V). Service and adjustments should be performed only by qualified service personnel.

8-8. Any adjustment, maintenance, and repair of the opened instrument under voltage should be avoided as much as possible and, when inevitable, should be carried out only by a skilled person who is aware of the hazard involved.

8-9. Capacitors inside the instrument may still be charged even if the instrument has been disconnected from its source of supply.

WARNING

The service information is often used with power supplied and protective

covers removed from the instrument. Energy available at many points may, if contacted, result in personal injury.

8-10. PRINCIPLES OF OPERATION

8-11. Instrument operation is described under the Principles of Operation on the service sheets. Service Sheet 1, in conjunction with the Troubleshooting Block Diagram, describes overall operation of the Frequency Extension Module. Service Sheets 2 through 7 explain the function of each circuit within the unit. The particular circuit described is shown in schematic form on the accompanying circuit diagram.

8-12. TROUBLESHOOTING

NOTE

When a malfunction occurs, refer to Section VIII of the HP Model 8660series mainframe Operating and Service Manual to begin troubleshooting (see System Troubleshooting Guide). Then, if that information does not isolate the problem to a definite instrument, refer to the Systems Troubleshooting information which preceeds Service Sheet 1 in the RF Section manual. This information may be used to isolate the defect to the Frequency Extension Module, another plug-in, or the mainframe. If the problem is in this module, refer to Service Sheet 1 for further troubleshooting information.

8-13. Because feedback circuits extend over several assemblies for each of the phase lock loops, the major troubleshooting tests are on Service Sheet 1 with the Troubleshooting Block Diagram. Once the fault is localized, additional tests on the remaining Service Sheets help locate the defective component.

8-14. Troubleshooting Aids

8-15. Circuit Board Aids. Test points are physically located on the circuit boards as metal posts or circuit pads and usually have either a reference designator (such as TP1) or a label which relates to the function (+20V, 20 MHz IN, etc.) Transistor emitters, diode cathodes, the positive lead of electrolytic capacitors, and pin 1 of integrated circuits are indicated by some special symbol such as E, a diode symbol, +, a teardrop shape or square circuit pad.

8-16. Service Sheet Aids. Signal levels, dc voltages, and logic states are shown as an aid in trouble-shooting on the schematic diagrams. Individual circuit areas are given descriptive names to identify functions and provide easy means for reference. Where needed, notes are used to explain circuits or mechanical configurations not easily shown on the schematic.

8-17. The locations of individual components mounted on printed circuit boards are shown on the pictorial representation of the circuit boards of the related service sheet. Chassis mounted parts, major assemblies, and adjustment locations are found on the last foldout in this manual.

8-18. Figure 8-1, Schematic Diagram Notes, provides information relative to symbols shown on the schematic diagrams.

8-19. Service Kit and Extender Boards. The HP 11672A Service Kit contains interconnect cables, RF cables, various coaxial adaptors, and an adjustment tool, all of which are useful in servicing the Frequency Extension Module. Refer to the HP 11672A Operating Note and the 8660-series mainframe manual for a listing and pictorial representation of the contents.

8-20. Circuit board extenders are provided with the mainframe. These extender boards enable the technician to extend plug-in boards clear of the assembly to provide easy access to components and test points.

8-21. RECOMMENDED TEST EQUIPMENT

8-22. Table 1-1 lists the test equipment and accessories recommended for use in servicing the instrument. If any of the recommended test equipment is unavailable, instruments with equivalent specifications may be used.

8-23. REPAIR

8-24. Non-Repairable Assemblies

8-25. Repairs should not be attempted on the following assemblies if any is found to be defective during troubleshooting:

- A1A3 4 GHz Low Pass Filter Assy
 A1U1 Sampler/1.8 GHz Low Pass Filter Assy
 A1U2 VCO/Mixer Assy
 A1U3 4.43 GHz Oscillator/Mixer Assembly
 A8 50 MHz Filter Assy
 A9 20 MHz Filter Assy
 A10 YIG Oscillator Assy
- A11 2.6 4.1 GHz Bandpass Filter Assy
- A12 4.43 GHz Bandpass Filter Assy

8-26. Removal and Disassembly Procedures

8-27. The procedures for removing the Frequency Extension Module from the mainframe, removing the cover, and gaining access to internal assemblies are found on the left hand foldout page which faces the last foldout in this manual.

8-28. The machine screws used throughout the Frequency Extension Module have a Pozidriv head. Pozidriv is very similar in appearance to the Phillips head, but using a Phillips screwdriver may damage the Pozidriv screw head. A Pozidriv screwdriver is recommended.

*	Asterisk denotes a factory-selected value. Value shown is typical. Part might be omitted. See Table 5-1.
4	Tool-aided adjustment. O Manual control.
	Encloses front-panel designation.
[]	Encloses rear-panel designation.
	Circuit assembly borderline.
	Other assembly borderline. Also used to indicate mechanical inter- connection (ganging) and RF shielding.
	Heavy line with arrows indicates path and direction of main signal.
	Heavy dashed line with arrows indicates path and direction of main feedback.
≰ CW	Wiper moves toward CW with clockwise rotation of control (as viewed from shaft or knob).
全	Numbered Test point. Meas- urement aid (metal post, cir- cuit pad, etc.) provided.
\Box	Encloses wire color code. Code used is the same as the resistor color code. First number identifies the base color, second number identifies the wider stripe, third number identifies the narrower stripe. E.G., (947) denotes white base, yellow wide stripe, violet narrow stripe.
	Stabistor
	Coaxial or shielded cable.
	Stripline (i.e., RF transmission line above ground).

Figure 8-1. Schematic Diagram Notes (1 of 2)



Figure 8-1. Schematic Diagram Notes (2 of 2)

SERVICE SHEET 1

NOTE

When a malfunction occurs, refer to Section VIII of the HP Model 8660series mainframe Operating and Service Manual to begin troubleshooting (see System Troubleshooting Guide). Then, if that information does not isolate the problem to a definite instrument, refer to the Systems Troubleshooting information which preceeds Service Sheet 1 in the RF Section manual. This information may be used to isolate the defect to the Frequency Extension Module, another plug-in, or the mainframe. If the problem is in this module, this Service Sheet contains troubleshooting procedures for isolating the problem to a circuit board or module.

FREQUENCY EXTENSION MODULE

TROUBLESHOOTING TESTS

Malfunctions in the Frequency Extension Module generally fall into one of the following three catagories as observed at the RF Section front panel output: no output; an unwanted FM or sluggish frequency change; wrong output frequency. The tests on this service sheet are designed for a logical sequence of tests to determine the part or parts that need replacement. It is therefore recommended that the tests be performed in the order given. Refer to the Simplified Block Diagram for the functional relationship of the Frequency Extension Module circuits.

a. No RF Output. After verifying that the power supply voltages are correct, troubleshooting begins by verifying that both RF outputs are present. If the Sum Loop voltage controlled oscillator (VCO), the YIG oscillator, or the 4.43 GHz local oscillator are not working, there will be no output at the RF Section output port. This is checked in Tests 2 and 3.

b. Unwanted FM or sluggish change of frequency. If the YIG Loop search circuits do not turn off, the output will include an FM sweep of about 40 MHz at one kilohertz rate. If the search circuit is inoperative, a change of frequency will appear sluggish. The search circuit is checked in Test 7.

c. Wrong Frequency. If only certain frequencies are wrong the fault is probably in one of the pretune sections. If these are among the 100 MHz steps (100 to 1200 MHz), the fault is probably in the YIG Loop Pretune Section, for smaller steps the fault is probably in the Sum Loop Pretune Section. Frequency problems are checked in tests 5 through 12 for the YIG Loop and tests 13 through 16 for the Sum Loop.

TROUBLESHOOTING BLOCK DIAGRAM

The troubleshooting block diagram on this Service Sheet shows the relationship between all printed circuit board assemblies and all modules. Use the block diagram and troubleshooting procedures following the principles of operation to isolate a trouble to a specific assembly. Then turn to the Service Sheet for that assembly and isolate the trouble to a specific component.

The large numbers in the lower right corner of each of the major blocks identify the Service Sheet which provides schematics and principles of operation for that particular assembly.

PRINCIPLES OF OPERATION

General

The Hewlett-Packard Model 11661A Frequency Extension Module (with a suitable RF Section) increases the frequency range of the Model 8660 mainframe above 160 MHz while maintaining 1 Hz frequency resolution. Four input signals from the mainframe are used to produce two output signals for the RF Section. These output signals are up-converted in frequency to ensure low spurious sidebands in the final output but still contain all frequency information selected in the mainframe.

A SUM phase lock loop combines 1 Hz step information, 10 MHz step information (from mainframe RF regerence signal and BCD coded logic), and the 4.43 GHz free-running internal local oscillator. A YIG phase lock loop combines a 100 MHz reference, 100 MHz steps from BCD coded logic, a 20 MHz reference (frequency modulated if FM is present), and the 4.43 GHz internal local oscillator frequency. Note that both output signals contain the 4.43 GHz oscillator frequency. This frequency component (including any drift) is cancelled in the RF Section mixer.

Power supply and RF interconnections between the Frequency Extension Module and the mainframe pass through the RF Section. The RF Section also contains a 20 MHz amplifier for the 20 MHz FM/CW reference signal. Digit 8, 9, and 10 BCD logic input lines do not pass through the RF Section but connect directly to the mainframe.

4.43 GHz Oscillator

The 4.43 GHz oscillator circuit is divided between the A1U3 and the A1A4 assemblies. The oscillator itself is located on the A1U3 module and receives two inputs from the A1A4 Oscillator Tuning Assembly: -10 Vdc filtered and an adjustable supply source derived from +20 Vdc whose value is adjusted by R1 to control the frequency of the oscillator. This oscillator is not phase locked as the 4.43 GHz frequency drift is cancelled out in the RF Section mixer.

Sum Loop

The Sum Loop inputs from the mainframe include 30 to 20 MHz (1 Hz steps), 450 to 360 MHz (10 MHz steps), and Digit 8 BCD code logic. The Digit 8 input logic to the A4 Sum Loop Pretune Assembly is converted to an analog voltage and then combined with a phase error signal to tune the Sum Loop VCO (voltage controlled oscillator). The 450 to 360 MHz is mixed in the A8 module with the Sum Loop 1st IF to produce a 30 to 20 MHz Sum Loop 2nd IF. This signal goes to the A3 Sum Loop Phase Detector Assembly where it is compared with the 30 to 20 MHz signal from the mainframe as part of the phase lock loop. The Sum Loop therefore contains all frequencies up to and including the first eight digits (0 to 99.999 999 MHz in 1 Hz steps).

YIG Loop

The YIG Loop inputs from the mainframe include 20 MHz FM/CW reference, 100 MHz reference, and Digits 9 and 10 BCD code logic. The Digits 9 and 10 input logic to the A5 YIG Loop Pretune Assembly is converted to an analog current and used to drive the coarse tuning coil of the YIG oscillator. Part of the YIG output is fed back to the first mixer to produce YIG Loop 1st IF. The difference frequency between the 4.43 GHz oscillator and the YIG oscillator will be in the range of 480 MHz to 1680 MHz in 100 MHz steps. The step recovery diode on the A1U1 assembly generates harmonics of the 100 MHz reference input. The difference between one of these harmonics and the 1st IF will be 20 MHz which is the 2nd IF. For example, if the 1st IF is 680 MHz, the 7th harmonic of 100 MHz will produce the 20 MHz 2nd IF. This 20 MHz 2nd IF is locked to the 20 MHz FM/CW reference from the mainframe in the YIG loop phase detector circuits. If phase locked, the phase difference produces a dc error for fine tuning the YIG oscillator. If not phase locked, logic circuit activates the search waveform generator in the FM Driver Assembly. The YIG loop output is frequency dependent on the 100 MHz reference harmonic, the 4.43 GHz oscillator, and the 20 MHz FM/CW reference.

TROUBLESHOOTING

It is assumed that a problem has been isolated to the Frequency Extension Module as a result of using the System Troubleshooting Guide found in Section VIII of the HP Model 8660-series mainframe Operating and Service Manual and the Systems Troubleshooting information preceeding Service Sheet 1 in the RF Section manual. Troubleshoot the Frequency Extension Module using the test equipment, information, and procedures which follow.

Test Equipment

Microwave Frequency	7 C	ou	ntei	[HP	53	40A
Spectrum Analyzer		•	HP	855	55 <i>I</i>	4/8	552]	B/1	40T
Oscilloscope .			HP	180)C/	180)1A	(18)	21 A
10:1 Divider Probe				•			HP	10	004
Digital Voltmeter			•	HP	34	740)A/3	847	02A
Extender Cable .				•	HF	211	672	-60	002
Extender Board				•		HP	506	0-0	258

Test 1. First check the power supply inputs to the Frequency Extension Module by removing the A3 printed circuit assembly (green extractor) and replacing it with the extender board. Check the voltages as listed below; the tolerance is ± 0.1 volt:

Power Supply Voltages at A3 Connector

Pin	с	E	F	н	J
Volts	Ground	+5.25	-40.0	-10.0	+20.0

Replace the A3 printed circuit assembly.

CAUTION

Always turn instrument power off before removing or installing any assembly.

Test 2. Turn the instrument off, remove the Frequency Extension Module from the main-frame, and reconnect using the extender cable.

Unplug the 20 MHz output cable (W4) from the A1J4. Connect an oscilloscope to test point A6TP1 and check for a +2.5 Vpk sawtooth ramp. Adjust A7R17 so the ramp just turns on. Reconnect the 20 MHz output cable. The signal at A6TP1 should now be 0.0 ± 0.1 Vdc.

Tune mainframe from 0 to 1200 MHz center frequency in 100 MHz steps. Verify that the signal at A6TP1 remains at 0.0 ± 0.1 Vdc. If the signals at A6TP1 are correct, check the YIG loop output frequencies at J1 as given in Table 8-1. If these frequencies are correct go to test 3 to continue testing, if not, go to test 5.

Test 3. If the YIG loop is operating at the correct output frequencies (Test 2), reconnect the counter to J1 and check the SUM loop output frequencies as follows: Tune mainframe from 0 to 90 MHz in 10 MHz steps and verify that the SUM loop output steps up from 3.95 GHz to 4.05 GHz matching the mainframe 10 MHz steps. If these frequencies are correct go to test 4 to continue testing, if not, go to test 13.

Test 4. If the results of tests 2 and 3 are good, use the spectrum analyzer to measure the power output as follows:

Power Outputs to RF Section

Output	Connector	Power Level
SUM LOOP	J1	≥4 dBm
YIG LOOP	J2	≥ +10 dBm

If the SUM loop power output is low go to Service Sheet 3 and troubleshoot the VCO circuit. If the YIG loop power output is low go to Service Sheet 5 and check the YIG oscillator output. If no problem has been encountered as a result of these tests, check the interconnecting cables to the RF Section as the Frequency Extension Module is working properly.

Test 5. Remove the A6 printed circuit assembly (red extractor). Tune the mainframe 0 to 1200 MHz center frequency as shown in Table 8-1 to check the YIG Pretune Driver circuits. Use the tolerance values for YIG Loop Pretune.

If the YIG loop frequencies are within tolerance, proceed to test 6, if not check the pretune input logic levels as shown on the block diagram for A5 pins 1 through 5. If the logic levels are correct go to SS2, if incorrect check interconnections and signals from the mainframe.

Test 6. Replace the A7 printed circuit assembly (brown extractor) with the extender card. Measure the 20 MHz FM/CW reference from the mainframe using the frequency counter (with the counter locked to the 10 MHz mainframe reference). Also check the 100 MHz reference from the W3 cable at connector A1J2. If incorrect check interconnections and signals from the mainframe. If correct proceed to test 7.

Test 7. Check the YIG Loop Phase Detector circuits by connecting the 20 MHz FM/CW reference into both A7 Assembly inputs. The simplest

Center Frequency	YIG Loop Output Frequency	YIG Loop Pretune Tolerance	YIG Loop Locked Tolerance
0000 MHz	3.950 GHz	±5 MHz	±1.5 MHz
0100 MHz	3.850 GHz	±5 MHz	±1.5 MHz
0200 MHz	3.750 GHz	±5 MHz	± 1.5 MHz
0300 MHz	3.650 GHz	±5 MHz	±1.5 MHz
0400 MHz	3.550 GHz	±5 MHz	±1.5 MHz
0500 MHz	3.450 GHz	±5 MHz	$\pm 1.5 \text{ MHz}$
0600 MHz	3.350 GHz	±5 MHz	±1.5 MHz
0700 MHz	3.250 GHz	±5 MHz	±1.5 MHz
0800 MHz	3.150 GHz	±5 MHz	$\pm 1.5 \text{ MHz}$
0900 MHz	3.050 GHz	±5 MHz	±1.5 MHz
1000 MHz	2.950 GHz	±5 MHz	±1.5 MHz
1100 MHz	2.850 GHz	±5 MHz	$\pm 1.5 \text{ MHz}$
1200 MHz	2.750 GHz	±5 MHz	±1.5 MHz

Table 8-1. YIG Loop Output Frequency Versus Mainframe Tuning*

way to do this is to extend the A7 Assembly using the test board described on the last foldout of this section. Place test board switch A in the test position. Reinstall the A6 Assembly. Use a digital voltmeter to check A6TP1 for 0.0 ± 0.1 Vdc. If incorrect proceed to test 8, if correct proceed to test 10.

Test 8. Check the dc voltage at A7 pin J (search control output) for 0 Vdc (not +3 Vdc). If correct proceed to Service Sheet 5, if incorrect go to Service Sheet 4 and troubleshoot the A7 Assembly.

Test 9. Move the digital voltmeter probe to A7TP2 which should also give a reading of 0.0 ± 0.1 Vdc. If this voltage is correct proceed to Service Sheet 5 and troubleshoot the A6 Assembly, if incorrect, proceed to Service Sheet 4 and troubleshoot the A7Assembly.

Test 10. Connect the spectrum analyzer to A1J4 and measure the amplitude of the signal at 20 MHz. If the signal is less than -17 dBm, adjust A1A1C1 to peak signal. If the signal is equal or greater than -17 dBm proceed to test 12, if not go to test 11.

Test 11. Set the mainframe center frequency to 500 MHz. Disconnect cable A11W3 at A1J1 and connect the cable to the spectrum analyzer. Check the signal at 3.45 GHz for an amplitude of -5 dBm or greater. Also check the high and low band edges for frequency and levels shown on the block diagram. If these signals are correct proceed to Service Sheet 3 and troubleshoot the A1 Assembly. If the signal level is incorrect, check the A10 output level at 3.45 GHz. If the level is +10 dBm or greater replace A11; if less proceed to Service Sheet 5 and troubleshoot the A10 Assembly.

Test 12. Connect the spectrum analyzer to the end of cable W2 where it connects to A2J4 and measure the 20 MHz output of the A9 Assembly. If the level is -6 dBm or more check for intermit-

tant or poor connections in the 2nd IF line. If the signal is less than -6 dBm replace the A9 assembly.

Test 13. If the frequencies measured in Test 3 were incorrect, check the digital pretune logic levels at A4 pins K, L, M, and N. If correct, disconnect W8 from A2J2 and connect the cable to the spectrum analyzer and check for the 20 to 30 MHz signal level of -5 to -8 dBm. Connect the spectrum analyzer to W6 by disconnecting the cable at A8 J2 and check for an input level of from +13 to +15 dBm. If any measurement in this test is incorrect, trace the line back through the RF Section to the mainframe for continuity.

Test 14. Check the SUM Loop Phase Detector circuits by connecting the 20-30 MHz input into both A3 Assembly inputs. The simplest way to do this is to extend the A3 Assembly using the test board described on the last foldout of this section. Place test board switch B in the test position. Use a digital voltmeter to check A3TP1 for $\pm 10 \pm 1$ Vdc. If this is out of range, proceed to Service Sheet 6 and troubleshoot the A3 Assembly. If the voltage is correct, remove the extender board and continue with test 15.

Test 15. Connect the spectrum analyzer to A1J6. If the 480-380 MHz signal has an amplitude of -6 dBm or more, replace the A8 Assembly. If the signal is incorrect go to test 16.

Test 16. Use an extender board to gain access to the edge connector of the A4 Sum Loop Pretune Assembly. Connect a digital voltmeter to pin 1 of the extender board and measure the dc voltage while tuning the mainframe from 0 to 90 MHz in 10 MHz steps. The voltage should change from -10 Vdc to -26 Vdc as the frequency is stepped. If voltages are correct proceed to Service Sheet 2 and troubleshoot A1U2 and A1A2. If they are incorrect go to Service Sheet 7 and troubleshoot the A4 Sum Loop Pretune Assembly.



Figure 8-2. Simplified Block Diagram

.





NOTES: *W11 IS A FACTORY SELECTED PART WHICH MAY BE OMMITED.

LO SIGNAL (SUM LOOP OUTPUT) 3.95 TO 4.05 GHz (1 Hz STEPS) >-4 dBm (TYP 0 TO 3 dBm)

P4 (MATES WITH J4 IN MAINFRAME)

A W1 20 MHz	(CW/EM)
B W8 20-30 Mł	<u>+z</u> (SI -1)
C W6 360-450 /	WHz (SE I)
D W3 100 MHz	
	<u>SIT</u> (D8-1)
V 935 20 MHz E	3IT (D8-2)
W 936 40 MHz E	<u>BIT</u> (D8-4)
X 037 80 MHz E	BIT (D8-8)
Y 038 100 MHz	BIT (D9-1)
Z 946 200 MHz	BIT (D9-2)
AA 947 400 MHz	BIT (D9-4)
BB 948 800 MHz	BIT (D9-8)
	T (D10)
>EE 927	
MM 7	
NN 97	-101/
	+5 251/
	+201/

RF SIGNAL (YIG LOOP OUTPUT) 3.95 TO 2.75 GHz (100 MHz STEPS) >+10 dBm (TYP +11 TO +15 dBm) TO RF SECTION VIA MAINFRAME

A1 OSC/MIXER HSG (TOP VIEW) U3 U1 U1, U2, & U3 PIN NUMBER ALLOCATIONS

Figure 8-3. Troubleshooting Block Diagram

SERVICE SHEET 2

NOTE

When a malfunction occurs, refer to Section VIII of the HP Model 8660-series mainframe Operating and Service Manual to begin troubleshooting (see System Troubleshooting Guide). Then, if that information does not isolate the problem to a definite instrument, refer to the Systems Troubleshooting information which preceeds Service Sheet 1 in the RF Section manual. This information may be used to isolate the defect to the Frequency Extension Module, another plug-in, or the mainframe. If the problem is in this module, refer to Service Sheet 1 for further troubleshooting information.

A5 YIG PRETUNE DRIVER ASSEMBLY

PRINCIPLES OF OPERATION

The A5 YIG Pretune Driver Assembly converts the binary logic of the $\underline{0000}$ MHz, $\underline{0100}$ MHz ... $\underline{1200}$ MHz (digits 9 and 10) to a dc current to pretune the YIG oscillator. The assembly includes a digital to analog converter, current driver, and reference voltages for the converter.

Digital/Analog Converter

Five potentiometers are provided to adjust each logic line for binary weighted current necessary to correctly tune the YIG pretune circuit.

For example if 1 GHz is entered on the mainframe, a logic high will be present on XA5 pin 5 of the YIG Pretune Driver Assembly. The output of A5U1C pin 8 is at a logic low turning off A5Q5 which depletes current from the node at A5TP2.

Current Summing Node (A5TP2)

The sum of the current from the D/A converter and the feedback from the Current Sense Resistor is constant at summing node A5TP2. The magnitude of this sum is set by Offset Adjustment A5R29. The higher the frequency entered on the mainframe, the higher the D/A current into the node and therefore the lower the feedback current.

Current Driver

A5Q6, A5U2, and A5Q7 form an operational amplifier circuit. The non-inverting input at A5Q6 pin 6 is grounded and inverting input pin 2 connects to the current node. A5U2 provides high



Troubleshooting Block Diagram SERVICE SHEET 1

a.

SERVICE SHEET 2 (Cont'd)

open loop gain and source follower A5Q7 ensures little loading of the integrated circuit by the output amplifier.

Output Amplifier

Parallel transistors A5Q8 and A5Q9 drive the YIG main tuning coil. A5C6, A5C7 and A5R42 prevent noise from reaching the YIG coil. VR4, CR2, and A5C8 suppress switching transients from the YIG coil, preventing them from reaching the current driver amplifiers or power supplies. Resistors A5R43 and A5R45 sense the current through the YIG coil and provide the source for the current feedback.

TROUBLESHOOTING

It is assumed that the troubleshooting information on Service Sheet 1 was used to isolate a circuit defect to the assemblies or cables shown on the accompanying diagram. Troubleshoot the YIG Pretune Driver Assembly by using the test equipment and procedures given below.

Test Equipment	Model
Spectrum Analyzer HP 8555A/85	52B/140T
Digital Voltmeter HP 34740.	A/34702A
Service Kit H	IP 11672A

Test 1. Check the power supply inputs to the A5 Assembly (+20V, -10V, and -40V). Also check the +9 VF, +5V, and the anode of A5CR3 (-9 Vdc). If correct, proceed to Test 2. Otherwise check for continuity of interconnections to mainframe or an A5 Assembly defect.

Test 2. If only one of the stepping codes gives improper tuning to the YIG oscillator, the problem is probably in one of the input inverter-transistor circuits. Enter the frequency indicated on the input line and check the output of the inverter for a logic low. The associated transistor should be conducting (collector-emitter = about 0.2 Vdc). Note that in this application the transistor collector acts as an emitter.

Test 3. If all steps give improper tuning, check the current driver section of the board. The collectors of A5Q6 and A5Q7 should be about +5 Vdc. At 0 GHz A5TP1 should be about 9.48 Vdc; A5Q8 and A5Q9 should be about +10.2 Vdc on their bases; A5Q7 should be about +11 Vdc at the gate and about +20 Vdc at the drain. The most likely components in this circuit to fail are operational amplifier A5U2 or FET A5Q7.

Model 11661A



Figure 8-4. A5 YIG Loop Pretune Assembly Component and Test Point Locations

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Figure 8-5. YIG Loop Pretune Section Schematic Diagram

SERVICE SHEET 3

NOTE

When a malfunction occurs, refer to Section VIII of the HP Model 8660-series mainframe Operating and Service Manual to begin troubleshooting (see System Troubleshooting Guide). Then, if that information does not isolate the problem to a definite instrument, refer to the Systems Troubleshooting information which preceeds Service Sheet 1 in the RF Section manual. This information may be used to isolate the defect to the Frequency Extension Module, another plug-in, or the mainframe. If the problem is in this module, refer to Service Sheet 1 for further troubleshooting information.

OSCILLATOR/MIXER SECTION

PRINCIPLES OF OPERATION

The 4.43 GHz oscillator, IF filters, IF amplifiers, and the VCO for the SUM loop are included on this Service Sheet. Both outputs to the RF Section are also shown.

A11 2.6 - 4.1 GHz Bandpass Filter Assembly

This is a non-repairable unit which includes a directional coupler and a bandpass filter. The 3.95 - 2.75 GHz signal passes through this unit to the RF Section. Part of this signal is filtered and sent to the mixer in the 4.43 GHz Oscillator Assembly.

A1A4 4.43 GHz Oscillator Tuning Assembly

This assembly provides interface connections for the A1U3 microcircuit oscillator and YIG Loop 1st IF mixer. Supply voltage for the 4.43 GHz oscillator is obtained from frequency adjustment potentiometer R1 which is mounted on the Frequency Extension Module frame. The voltage from R1 is filtered by A1A4C1, A1A4R2, and A1A4C3.

The oscillator frequency adjustment potentiometer R1 is mounted on the main Frequency Extension Module housing. This adjustment determines the dc supply voltage to set A1U3 microcircuit oscillator frequency to 4.43 GHz. The 4.43 GHz Oscillator Tuning Assembly contains filtering for this voltage and the oscillator -10 Vdc supply.

Microcircuit A1U3 contains the 4.43 GHz oscillator and the mixer for the Sum Loop. The 4.43 GHz oscillator is free-running (not phase locked), but as this frequency is part of both the Sum and YIG loops any drift is exactly cancelled in the RF Section mixer. The microcircuit is mechanically attached to the A1 housing but interfaces electrically with the A1A4 assembly.

SERVICE SHEET 3 (Cont'd)

A1U3 4.43 GHz Oscillator/Mixer Assembly

This unit is a non-repairable microcircuit containing the 4.43 GHz oscillator and the YIG Loop 1st IF Mixer. An output of this oscillator is also used to drive SUM Loop 1st IF mixer which is part of the A1U2 microcircuit.

A1A3 4 GHz Low Pass Filter Assembly

This unit attenuates the level of the 4.43 GHz contained in the ouput of the YIG Loop 1st IF Mixer. It is a non-repairable assembly.

A1U1 Sampler/1.8 GHz Low Pass Filter Assembly

The output of the 4 GHz Low Pass Filter Assembly next passes through the 1.8 GHz Low Pass Filter in the A1U1 microcircuit. This attenuates the level of the 3.95 to 2.75 GHz decoupler RF contained in the YIG Loop 1st IF. A sampler generates the YIG Loop 2nd IF. It may be visualized as a harmonic mixer, in which a step recovery diode generates harmonics of the mainframe 100 MHz reference signal. This is combined with the 1st IF to produce many frequency products including the 20 MHz 2nd IF frequency.

A1A1 20 MHz IF Amplifier Assembly

This assembly is a printed circuit board which serves as an interface for the A1U1 microcircuit and the YIG Loop 20 MHz second IF amplifier. Adjustable capacitor A1A1C1 with inductor A1A1L2 provides a 20 MHz parallel resonant filter circuit. In spite of this, the output of the 20 MHz IF amplifier contains considerable 100 MHz feedthrough. Therefore the amplitude of the 20 MHz signal should be determined using a spectrum analyzer.

A1U2 VCO/Mixer Assembly

This unit is a non-repairable microcircuit containing the 3.950/4.050 GHz VCO and the Sum Loop 1st IF mixer. The output of the VCO is the Sum loop output to the RF Section (in the RF Section it serves as the local oscillator signal). The mixer combines the VCO signal with the 4.43 GHz signal from the A1U3 microcircuit to form the Sum Loop 1st IF.

A1A2 380-480 MHz IF Amplifier Assembly

This assembly is a printed circuit board which serves an interface for the A1U2 microcircuit and the Sum Loop 1st IF amplifier. A1A2R3 provides adjustment for the A1U2 VCO bias.

A12 4.43 GHz Bandpass Filter Assembly

This filter is a non-repairable assembly used to couple the 4.43 GHz oscillator output to the Sum Loop 1st IF mixer. This filter reduces spurious outputs between the two units.

SERVICE SHEET 3 (Cont'd)

A8 50 MHz Filter Assembly

This is also a non-repairable assembly and uses the Sum Loop 1st IF and the 450 to 360 MHz input from the mainframe to produce the Sum Loop 2nd IF. The 2nd IF will be in the range of 30 to 20 MHz and contains the 1 Hz step information.

TROUBLESHOOTING

It is assumed that the troubleshooting information on Service Sheet 1 was used to isolate a circuit defect to the assemblies or cables shown on the accompanying diagram. Troubleshoot the circuits using the test equipment and procedures given below.

Test Equipment			Model
Spectrum Analyzer			HP 8555A/8552B/140T
Digital Voltmeter		•	. HP 34740A/34702A
Service Kit	•		HP 11672A

Test 1.Check the power supply inputs to assemblies where a defect has been indicated.

Test 2. If a problem is indicated in A1U2 SUM loop VCO (Service Sheet 1) check the inputs and outputs as shown on the schematic diagram including the dc voltages. If all inputs are correct and either output incorrect replace the unit.

Test 3. If the A1U2 SUM loop VCO is operating properly but a problem exists in the 1st or 2nd IF, first check the associated dc voltage levels and then the signal levels as indicated on the schematic diagram.

Test 4. If the A1U3 4.43 GHz oscillator has no output or cannot be properly adjusted, check the dc voltage inputs to the microcircuit. If there is no tuning voltage at pin 2 of A1U3, use a voltmeter to trace the circuit back to R1.

Test 5. Sampler/1.8 GHz Low Pass Filter Assembly A1U1 is also a non-repairable assembly. If the inputs are correct and no or low output, the unit must be replaced. The output at pin 4 of A1U1 should be greater than 50 millivolts peak-to-peak.

Test 6. If the signal into the A1A1 assembly is correct but the output at A1J4 is incorrect, use an oscilloscope to trace the signal through the amplifier. The output at A1J4 may have considerable 100 MHz signal present which is normal and should not cause a problem.
Model 11661A







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Figure 8-7. Oscillator/Mixer Section Schematic Diagram



8-13

REFERENCE DESIGNATIONS					
NO PREFIX	A1A2 ASSY	A8 ASSY			
J1,2 P4 R1 W3-7	C1-8 L1-3 Q1-2 R1-10	C1-3 J1-3 L1-3 U1			
W9-13	A1A3 ASSY	All ASS.			
A1 ASSY	A1A4 ASSY	W1-3			
C1-7 11-7	C1-3	A12 ASSY			
R1-3 U1-3	R1-2 VR1	W1,2			
A1A1 ASSY	A2 ASSY				
C1-9 CR1 L1-3 Q1-3 R1-11	J1,3				



NOTE

When a malfunction occurs, refer to Section VIII of the HP Model 8660-series mainframe Operating and Service Manual to begin troubleshooting (see System Troubleshooting Guide). Then, if that information does not isolate the problem to a definite instrument, refer to the Systems Troubleshooting information which preceeds Service Sheet 1 in the RF Section manual. This information may be used to isolate the defect to the Frequency Extension Module, another plug-in, or the mainframe. If the problem is in this module, refer to Service Sheet 1 for further troubleshooting information.

YIG LOOP PHASE DETECTOR SECTION

This Service Sheet includes the YIG loop 2nd IF filter and two phase detectors. A quadrature phase detector supplies a search control output when loss of phase lock occurs. Another phase detector supplies a dc voltage (A7TP2) proportional to the phase error between the 20 MHz 2nd IF and the 20 MHz FM/CW reference signal.

A9 20 MHz Filter Assembly

This is a non-repairable assembly whose purpose is to remove the unwanted 100 MHz and other spurious signals on the YIG Loop 2nd IF signal. The 2nd IF signal is first processed by a 50 MHz low pass filter, then a 20 MHz bandpass filter, and then amplified by about 20 dB. The output of this assembly is an emitter follower which drives one input of the YIG Loop phase detector assembly.

A7 YIG Loop Phase Detector Assembly

The YIG Loop phase detector compares the 20 MHz 2nd IF with the 20 MHz reference input from the mainframe. The output of this assembly includes a dc error signal during phase lock and a search control command during an unlocked condition.

 90° Phase Shifter. The input circuit to A7Q4 shifts the phase of the 20 MHz reference signal about 90° . Capacitor A7C2 is used to adjust the exact phase so that the search command will not be turned on when the YIG loop is phase locked.

20 MHz Limiter/Amplifiers. Three integrated circuits are used to amplify and limit the 20 MHz signals: one for the 20 MHz reference, one for the 90° phase shifted 20 MHz reference, and one 20 MHz 2nd IF.

A1 Oscillator/Mixer Housing Assembly A8 50 MHz Filter Assembly A11 2.6–4.1 GHz Bandpass Filter Assembly A12 4.43 GHz Bandpass Filter Assembly

SERVICE SHEET 3

SERVICE SHEET 4 (Cont'd)

Quadrature Phase Detector. The quadrature phase detector circuit compares the 20 MHz 2nd IF with the 90° phase shifted 20 MHz reference to detect an unlocked condition. Two gates on A7U4 form an exclusive OR gate where the output is low only when the inputs are out of phase.

20 MHz Phase Detector. Phase Detector A7U6 is a balanced mixer type detector which compares the 20 MHz 2nd IF with the 20 MHz reference. The output of the detector passes through a low pass filter to produce a dc voltage proportional to the phase difference.

TROUBLESHOOTING

It is assumed that the troubleshooting information on Service Sheet 1 was used to isolate a circuit defect to the assembly or cables shown in the accompanying diagram. Troubleshoot the A7 YIG Loop Phase Detector Assembly by using the test equipment and procedures given below.

Test Equipment	Model
Oscilloscope	HP 180C/1801A/1821A
10:1 Divider Probe	HP 10004
Digital Voltmeter	. HP 34740A/34702A
Service Kit	HP 11672A

Test 1. Check the power supply inputs to the A7 Assembly (+20 Vdc and -10 Vdc). Also check the +10 Vdc from the zener diode A7VR1 and the regulated -5 Vdc. If incorrect troubleshoot these circuits. If correct proceed to Test 2.

Test 2. If there is either no or low output at J2 of the A9 Assembly, check the input, cables, and -10 Vdc power supply input at A9C1. If no fault is found, replace the A9 Assembly.

Test 3. If the search control output was found faulty on Service Sheet 1, proceed as follows: With both RF inputs of the A7 Assembly driven from the 20 MHz reference, check pin 2 of A7U5 for about -1.2 Vdc. Pin 3 of A7U5 (or A7TP1) should be about -1.5 Vdc. (ECL logic levels are: on = -0.7 Vdc, off = -1.5 Vdc). If these inputs are correct A7U5 or A7VR3 is bad. If the voltage at A7TP1 is incorrect use an oscilloscope to check back to the RF inputs. The output of the Limiter Amplifiers (U1A pins 1 and 2, U3A pins 1 and 2) should be about 0.8 Vp-p.

Test 4. If the search control is working properly, compare the REF 20 MHz LIMITER/AMPL voltages and waveforms with the PHASE-SHIFTED 20 MHz LIMITER/AMPL voltages and waveforms. If one of the 20 MHz inputs is unplugged, the loop will be unlocked and the can be used for signal tracing through the phase detector and elliptic filter.



Figure 8-8. A7 YIG Loop Phase Detector Assembly Component and Test Point Locations





REFERENCE DESIGNATIONS

NO PREFIX	A9 ASSY
P4 W1, W2, W4	C1-C11 J1, J2
Á2 ASSY	Q1,Q2
J4, J5 XA7	R1-R7
A7 ASSY	
C1-C20 CR1 L1, L2 Q1-Q5 R1-R20 T1 U1-U5 VR1-VR3	

Figure 8-9. YIG Loop Phase Detector Section Schematic Diagram

NOTE

When a malfunction occurs, refer to Section VIII of the HP Model 8660-series mainframe Operating and Service Manual to begin troubleshooting (see System Troubleshooting Guide). Then, if that information does not isolate the problem to a definite instrument, refer to the Systems Troubleshooting information which preceeds Service Sheet 1 in the RF Section manual. This information may be used to isolate the defect to the Frequency Extension Module, another plug-in, or the mainframe. If the problem is in this module, refer to Service Sheet 1 for further troubleshooting information.

A6 FM DRIVER ASSEMBLY

PRINCIPLES OF OPERATION

The FM Driver converts the dc error signal derived from the phase detector section to drive current for the YIG FM coil. In the FM mode, FM is added to the 20 MHz reference signal in the Modulation Section, routed through an amplifier in the RF Section, and is present on the YIG FM coil. If phase lock with the 20 MHz 2nd IF is lost, the search control turns on the Search Waveform Generator.

DC Amplifier and Output Driver

Transistors A6U1, A6Q1, 2, 3, and 4 function as an operational amplifier. The non-inverting input is A6U1 pin 4 and the inverting input is A6U1 pin 2. The phase detector error signal from the YIG loop phase detector is connected to the non-inverting input. The output of this amplifier drives the FM coil in the YIG oscillator. Current sense resistor A6R37 developes a voltage proportional to the FM coil current. This voltage is fed back to the amplifier input at A6U1 pin 2.

Search Waveform Generator

When the YIG is unlocked, the search control input (+3 Vdc) enables the search waveform oscillator A6U2B and A6U2C. Gate A6U2A acts as an inverter turning on A6Q5 and FET A6Q6. The output of the search waveform oscillator is a squarewave and is connected to the FET drain through gate A6U2D. Resistor A6R18 and capacitor A6C11 convert the squarewave to a sawtooth for driving the inverting input to the amplifier section. The fine tune winding of the YIG will then sweep until the quaerature phase detector (search control) goes to zero. FET A6Q6 will then be cutoff but capacitor A6C11 will hold its charge long enough for the loop to lock.

A7 YIG Loop Phase Detector Assembly A9 20 MHz Filter Assembly SERVICE SHEET 4

SERVICE SHEET 5 (Cont'd)

A10 YIG Oscillator Assembly

The YIG Oscillator Assembly is non-repairable. The larger of two tuning coils is connected to the pretune circuit on the A5 Assembly. The smaller FM coil is connected to the A6 YIG FM Driver Assembly and is driven by the YIG phase detected error signal. The output of the YIG oscillator is therefore phase locked to the frequency digits 9 and 10 (100 MHz - 1200 MHz) and contains the FM if present.

TROUBLESHOOTING

It is assumed that the troubleshooting information on Service Sheet 1 was used to isolate a circuit defect to the assemblies or cables shown on the accompanying diagram. Troubleshoot the circuits using the test equipment and procedures given below.

Test Equipment	Model
Spectrum Analyzer .	HP 8555A/8552B/140T
Oscilloscope	HP 180C/1801A/1821A
Digital Voltmeter .	. HP 34740A/34702A
Service Kit	HP 11672A

Test 1. Check the power supply inputs to the A6 Assembly on the board. If any are missing, check for continuity of interconnections to the mainframe.

Test 2. To check the Search Waveform Generator proceed as follows. If the Search Control input is at a logic high, U2 pin 3 is low and A6Q5 will be turned ON. The output at U2 pin 11 will be a square wave, alternating between about 0 and 3.5 Vdc. The oscillator formed by A6U2B and A6U2C is ON at all times and has a period of about 5 milliseconds.

Test 3. Troubleshoot the amplifiers using the ramp waveform. With the search control active, use the oscilloscope to trace the ramp from U1 pin 2 (about 10 mV) to the output of the Output Driver. The signal amplitude at the base of A6Q3 should be about 10 Vp-p.

Test 4. If the tests on Service Sheet 1 shows that the YIG oscillator is far off frequency or has a low output signal amplitude, check the power supply voltages and interconnecting cables using the schematic diagram. If the inputs to the A10 YIG Oscillator Assembly are good, replace the entire assembly.

A6 ASSEMBLY OFFSET R33 CR11 02 VR1 **C8** CR4 CR5 CR6 Q3 CR10 CR3 R4 Que. CR8 CR9 C2 R2 CR2 C6 CR1 R1 Q6 Q1 R22 22 C16 R28 R27 R19 - R16 04 R14 C5 R10 CR7 C18 1 U2 R24 R26 C7 C19 C21 C4 R3 R5 **R8** C9 12 (N) 1 (A)



Figure 8-10. A6 FM Driver Assembly Component and Test Point Locations



Service

Figure 8-11. YIG Loop FM Driver/Oscillator Section Schematic Diagram

NOTE

When a malfunction occurs, refer to Section VIII of the HP Model 8660-series mainframe Operating and Service Manual to begin troubleshooting (see System Troubleshooting Guide). Then, if that information does not isolate the problem to a definite instrument, refer to the Systems Troubleshooting information which preceeds Service Sheet 1 in the RF Section manual. This information may be used to isolate the defect to the Frequency Extension Module, another plug-in, or the mainframe. If the problem is in this module, refer to Service Sheet 1 for further troubleshooting information.

A3 SUM LOOP PHASE DETECTOR ASSEMBLY

PRINCIPLES OF OPERATION

The A3 Sum Loop Phase Detector compares the 30-20 MHz (1 Hz steps) signal from the mainframe and the 30-20 MHz Sum Loop 2nd IF signal and provides a phase error signal to the A4 assembly to accomplish phase lock.

Pulse Generators

The Sum Loop 2nd IF signal input is amplified by A3Q5. The output of A3Q5 drives the pulse forming circuit A3U3A to speed up the rise and fall time for the logic elements. Feedback inductor A3L2 allows gate A3U3A to operate more in its linear region and convert the small signal input to logic level pulses. A similar circuit is used for the 20 to 30 MHz input signal from the mainframe.

Digital Phase Detector and Low Pass Filters

The digital phase detector compares the phase relationship of two signals in the 20 to 30 MHz range and produces a dc error voltage proportional to the difference. Gates A3U3C and A3U2A are connected to form a flip-flop circuit. The output of gate A3U3C pin 8 is set to a logic high by the input signal. The 2nd IF flip-flop is reset by A3U2C only after both input signals have set their respective flip-flops. The duration of the logic high at the phase detector outputs therefore depends on the phase of the input signals. The dc level output of one lowpass filter will then be proportional to the phase difference of the input signals, while the other output is a constant low dc level. If in phase, both flip-flops reset immediately and both outputs will be a constant low dc level.

Active Filter/Integrator

The output circuit forms a differential amplifier. The two outputs of the phase detector are connected to the two inputs of this amplifier. Further filtering of the phase detector signal is accomplished by feedback resistor A3R21 and capacitor A3C19. If the loop is locked the amplifier output will be about ± 10 Vdc. If the 2nd IF is absent, for example, the output of the assembly will be about ± 20 Vdc.



SERVICE SHEET 6 (Cont'd)

TROUBLESHOOTING

It is assumed that the troubleshooting information on Service Sheet 1 was used to isolate a circuit defect to the assemblies or cables shown on the accompanying diagram. Troubleshoot the circuits using the test equipment and procedures given below.

Test Equipment					Model
Oscilloscope .			HP 180	DC/1801	A/1821A
Digital Voltmeter			. HP	347404	A/34702A
Service Kit				H	P 11672A

Test 1. Check the power supply inputs to the A3 Assembly on the board (+20, +5.25 and -40 Vdc). Also check the +5 Vdc filtered. If any voltages are incorrect, check continuity back to the mainframe. If correct proceed to test 2.

Test 2. Connect the two signal inputs to the 30-20 MHz input from the mainframe as described in Test 14 on Service Sheet 1. Connect oscilloscope probe first to U3C pin 10 and then to U1B pin 4 comparing the waveforms (30-20 MHz pulses). If either of these two signals are missing, check back to the common input with the oscilloscope probe to identify the problem.

Test 3. Move the oscilloscope probe first to U3C pin 8 and then to U1B pin 6. If pulses are missing from either point, use a digital voltmeter to locate the problem.

Test 4. Use a digital voltmeter to compare the two halves of the output circuit. If the inputs are balanced, similar points should have the same dc voltage. Note that A3TP1 is about +10 Vdc for phase lock.







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Service

Figure 8-13. Sum Loop Phase Detector Section Schematic Diagram

NOTE

When a malfunction occurs, refer to Section VIII of the HP Model 8660-series mainframe Operating and Service Manual to begin troubleshooting (see System Troubleshooting Guide). Then, if that information does not isolate the problem to a definite instrument, refer to the Systems Troubleshooting information which preceeds Service Sheet 1 in the RF Section manual. This information may be used to isolate the defect to the Frequency Extension Module, another plug-in, or the mainframe. If the problem is in this module, refer to Service Sheet 1 for further troubleshooting information.

A4 SUM LOOP PRETUNE ASSEMBLY

PRINCIPLES OF OPERATION

The A4 Sum Loop Pretune Assembly converts the binary logic of the 10 MHz steps (digit 8) to a dc bias for coarse tuning of the VCO. This assembly includes a BCD to decimal decoder, a 4.05-3.95 GHz resistance ladder, and associated amplifiers. The pretune current is combined with the phase error signal from the A3 Assembly to produce the VCO control signal.

Logic Input

Inputs to XA4 pins N, M, L, and K are BCD code from the mainframe for digit 8 (10 MHz). Integrated circuit U1 converts the input from BCD to 10 line decimal. U1 also acts as a logic inverter so that only one line is ON (near ground) at any one time. The remaining lines will be above 3 Vdc. The digit selected will turn on one of the transistors Q1 through Q10. An adjustment for each transistor is provided for weighting the current for each digit.

Phase Error Signal

Transistor Q12 provides coupling of the phase error signal from the A3 Sum Loop Phase Detector Assembly. Potentiometer R6 provides an adjustment for controlling loop bandwidth at the low frequency end of the VCO range. Note that the higher the selected frequency, the lower the VCO tuning voltage. Transistor Q11 improves the high frequency response of the phase error signal. The voltage range of the tuning is from about -10 Vdc to about -16 Vdc.



SERVICE SHEET 7 (Cont'd)

TROUBLESHOOTING

It is assumed that the troubleshooting information on Service Sheet 1 was used to isolate a circuit defect to the assembly or cables shown in the accompanying diagram. Troubleshoot the A4 Sum Loop Pretune Assembly by using the test equipment and procedures given below.

Test Equipment		Model
Digital Voltmeter	•	HP 34740A/34702A
Service Kit .		HP 11672A

Test 1. Check the power supply inputs to the A4 Assembly (+20V, +5V, -10V), and -40V. If incorrect check for continuity back to the mainframe. If correct proceed to test 2.

Test 2. If a fault lies with the pretune logic decoding, check the collector of transistors A4Q1 through A4Q10 while exercising the digit 8 tuning on the mainframe (0 through 9). Each line should pull up to about 0 Vdc when the matching number is selected. If there is no change in the output of the A4 Assembly (pin 1) for the entire range of tuning, probably A4U1 is bad.

Test 3. The output of the A4 Assembly (pin 1) should be at about -10 Vdc for 4.05 GHz and -26 Vdc for 3.95 GHz tuning of the VCO. If the voltages fall much outside of this range check A4Q11 and A4Q12 and associated components for short or open failures.





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Figure 8-15. Sum Loop Pretune Section Schematic Diagram



NOTE

To show switch positions, make a label as shown below and attach to lettered side of the test board.

Switch	11	10	В	А
Normal	/	/	/	/
Test A3 (Green)	1	/	λ	1
Test A7 Brown)	/	/	/	۸.
Test A6 (Red)	١	\	/	/

GENERAL REMOVAL AND DISASSEMBLY PROCEDURE

WARNING

To avoid contact with the line voltage, remove the line (Mains) power cable from the power outlet before removing or connecting cables to the Frequency Extension Module.

a. Remove the mainframe top cover by first removing the four Pozidriv screws; then slide the cover back and off the mainframe side rails.

b. If the Frequency Extension Module is to be removed from the mainframe, remove the bottom cover in a similar manner.

Model 11661A Module Removal

a. Remove the two cables connected to J1 and J2 as shown in Figure 2-2.

b. Remove the three securing screws shown in Figure 2-2 holding the Frequency Extension Module cover to the mainframe.

c. Remove the two bottom screws holding the Frequency Extension Module. These screws are accessible from the bottom of the mainframe.

d. Lift straight up with a slight rotating action.

Interconnection of the Frequency Extension Module to the Mainframe for Troubleshooting Purposes

WARNING

With the mainframe top cover removed, power is supplied to the system during troubleshooting. Energy available at many points may, if contacted, result in personal injury.

a. Use extender cable HP 11672-60002 to connect J4 on the mainframe to P4 on the Frequency Extension Module.

b. Reconnect the RF connecting cables to J1 and J2 on the rear of the Frequency Extension Module. Refer to Figure 2-2 for cable color code.

NOTE

The interconnect cables and adaptors are found in the HP 11672A Service Kit. They may all be ordered in the kit or as individual pieces. Refer to the 11672A Operating Note or the Mainframe Manual for a pictorial cross reference.

Figure 8-16. 11661 Test Board

Service

GENERAL REMOVAL AND DISASSEMBLY PROCEDURE (Cont'd)

c. Reconnect the mainframe line (Mains) power cable to the power outlet and set the mainframe line switch to ON.

Access To Internal Assemblies

For access to the circuit boards, remove the three screws securing the cover to the case. Circuit boards A3, A4, A5, A6, and A7 may be unplugged by simultaneously pulling up on both plastic arms associated with that board.

Reassembly Procedure

Reassembly in reverse order of disassembly. Replace the top cover after verifying all boards are in place and then install in mainframe. Before replacing the instrument cover, verify that the two RF cables to J1 and J2 are properly installed as shown in Figure 2-2.

11661 TEST BOARD

Troubleshooting the 11661 phase lock loop circuit boards A3, A6, and A7 can be aided by constructing a special test board. This board uses a standard extender board, Hewlett-Packard part number 5060-0258, and four small SPDT toggle switches, HP part number 3101-0163 or equivalent.

Instructions For Construction

a. Open connections to blue ribbon (edge) connector pins A, B, 10, and 11 from extender board traces.

- b. Mount switches on lettered side of board.
- c. Wire as shown in Figure 8-16.
- d. Add label to show switch position.

Application

With A3 Extended: In the test position the two 20-30 MHz inputs are tied together and to the SL1 mainframe signal. In this state, A3TP1 should be approximately 20 Vdc.

With A6 Extended: The switches open the output lines to the YIG oscillator's FM coil.

With A7 Extended: The switches connect both YIG loop phase detector inputs to the 20 MHz mainframe reference. In this state A7TP2 should be 0 ± 0.1 Vdc.

Reference Designator	Service Sheet(s)	Figure(s)
A1 Assembly A1A1 Assembly A1A1C1 20 MHz Adi	3 3	8-6, 8-17 8-6, 8-17
AIAICI 20 MHZ Adj	3	8-6, 8-17
A1A2R3 VCO Bias Adj	3	8-6, 8-17
A1A3 Assembly A1A4 Assembly	3 3	8-6, 8-17 8-6, 8-17
A2 Assembly A3 Assembly	2,3,4,5,6 6	8-17 8-12, 8-17
A4 Assembly A4R5 O Adj	7 7	8-14, 8-17 8-14
A4R6 B Adj	7	8-14
A4R11 1 Adj A4R16 2 Adj A4R20 3 Adj	7 7 7 7	8-14 8-14 8-14
A4R23 4 Adj	7	8-14
A4R26 5 Adj A4R29 6 Adj	7 7	8-14 8-14
A4R32 7 Adj A4R35 8 Adj A4R38 9 Adj	7 7 7 7	8-14 8-14 8-14
A5 Assembly A5R13 "1" Adj A5R15 "2" Adj A5R17 "4" Adj	2 2 2 2 2	8-4, 8-17 8-4, 8-17 8-4, 8-17 8-4, 8-17
A5R19 ''8'' Adj A5R21 ''10'' Adj	2 2	8-4, 8-17 8-4, 8-17
A5R29 OFFSET Adj A5R39 GAIN Adj	2 2	8-4, 8-17 8-4, 8-17
A6 Assembly A6R6 DC OFFSET Adj	5 5	8-10, 8-17 8-10, 8-17
A7 Assembly A7C2 Phase Adj A7R17 Phase Ref Adj A7R20 YIG Loop Gain Adj	4 4 4 4 4	8-8, 8-17 8-8, 8-17 8-8, 8-17 8-8, 8-17 8-8, 8-17

Table 8-2. Assemblies, Chassis Mounted Parts, and Adjustment Locations (1 of 2)



Reference Designator	Service Sheet(s)	Figure(s)
A8 Assembly A9 Assembly A10 Assembly	3 4 5	8-17 8-17 8-17
A11 Assembly	3	8-17
A12 Assembly A13 Assembly	3	8-17
J1 J2 P4	3 3 2,3,4,5,6,7	$2-2, 8-17 \\ 2-2, 8-17 \\ 8-17$
W1, 2 W3	4 3	8-17 8-17
W4 W5 W6 W7 W8 W9-12 W13	3, 4 3 3 6 3 3 3	8-17 8-17 8-17 8-17 8-17

Table 8-2. Assemblies, Chassis Mounted Parts, and Adjustment Locations (2 of 2)



Figure 8-17. Assemblies, Chassis Mounted Parts, Adjustment Locations and Test Point Locations

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